



SCIENCE AND TECHNOLOGY OF MULTIFUNCTIONAL OXIDE AND ULTRANANOCRYSTALLINE DIAMOND (UNCD™) THIN FILMS AND APPLICATIONS TO A NEW GENERATION OF MULTIFUNCTIONAL DEVICES/SYSTEMS

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Lead Co-Founder of Original Biomedical Implants (OBI), Inc (June 2011)

Work supported by:
U.S. Department of Energy,
Office of Science-Basic Energy Science-Materials Science
Biomedical Engineering Research
DARPA-MTO-DSO
Industry

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Industrial Funding (2003)

INTEL (memories)

Industrial Funding (2004)

Delphi (R&D Fuel Cell)
Motorola (MEMS)
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C. Goldsmith (MEMtronics-
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B. Mech (Second Sight-Retina)
R. Reedy (Peregrine Semic.)

Funding: DOE (BES, BER, OIT, CESP) DARPA



Outline

- **Science and Technology of Multifunctional Oxide Thin Films and Applications:**
 - Ferroelectric & Multiferroic Films, Integration and Fabrication of Nanostructures for High-Density FeRAMS and Ferroic Devices, and for Novel High Efficiency Photovoltaic Devices
 - Doped NiO Films for Novel Correlated Electron Resistive-Change Random Access Memories (CeRAMs) Based on Resistive-Conductive Mott Transition
 - **Novel High-K Dielectric Super-lattice Oxide Films for Next Generation Nanoscale CMOS devices, Microchip Embedded Capacitors for implantable Biomedical Devices, and Supercapacitors for Energy Storage**
 - Piezoelectric films for MEMS/NEMS Devices
- **Science and Technology of a Novel Multifunctional Ultrananocrystalline Diamond (UNCD) Film and Application to a New Generation of Multifunctional Devices and Systems:**
 - **New Generation of Industrial Macro to Nano-Components and Devices**
 - Macro Scale (UNCD coated Mechanical Pump Seals)
 - Monolithically Integrated CMOS Driver/RF MEMS Switches with UNCD Fast Charging/Discharging Dielectric Enabling Reliable Switches for Radar and Mobile Communication Devices
 - Piezoelectrically actuated UNCD MEMS/NEMS structures for Resonators, Sensors, and Nanoswitches for new NEMS Logic System
 - **Science and Technology for a New Generation of Implantable Biomedical Devices and Platform for Developmental Biology Based on UNCD**
 - UNCD-Coated Microchip as Key Component of an Artificial Retina to Restore Sight to Blind People
 - UNCD-Coated Glaucoma Valve and Flexible Magnets to Treat Eye Pathologies
 - UNCD-Coated Artificial Joints, Heart Valves and Stents
 - UNCD surface as a platform for growth and Differentiation of Embryonic Stem Cells
- **Start-ups as a Pathway to Commercialization**
 - Advanced Diamond Technologies (ADT), Inc (2003-present)
 - Original Biomedical Implants (OBI), Inc. (2011- future)
- **Vision to the Future**

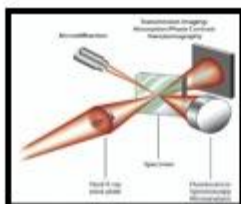


ANL Center for Nanoscale Materials (CNM)! ...

- Create and study novel multifunctional nanoscale materials and structures
- Access APS & Electron Microscopy Center



APS



Unique 30 nm diameter synchrotron X-ray beam

CNM Scientific Themes

- BioNanointerfaces
- Electronic and Magnetic Materials & Devices
- Nanophotonics
- Theory and Simulation
- Nanofabrication
- X-Ray Imaging/Nanoprobe



Only MPCVD for UNCD and other carbon films synthesis in a clean room



E-beam Lithography



FIB/SEM

Open for users from National Labs
Universities and Industry from
USA and International

www.nano.anl.gov



**Science and Technology of
Ferroelectric films for FeRAMs and
Piezoelectric MEMS
and
High - K Dielectric Oxide Films for Next
Generation Nanoscale CMOS Devices,
Microchip Embedded Capacitors for
Implantable Biomedical Devices, and
Super-capacitors for Energy Storage**

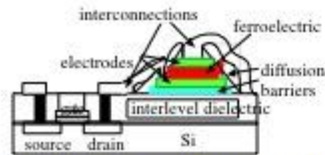




O. Auciello
US patent #7,714,405, May 2010



Ferroelectric Oxide Thin Films for Low Energy FeRAMs

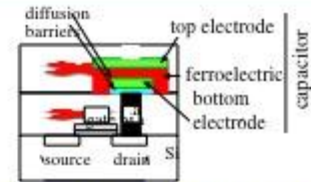


Low-density FeRAM architecture
In smart cards in the market



FeRAM Smart Cards
Auciello/Scott/Ramesh
(Physics Today 1998)
~ 1000 citations (2011)
Symetrix/Panasonic
SBT FeRAMs

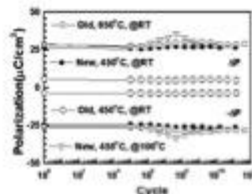
Ti, Toshiba-PZT FeRAMs



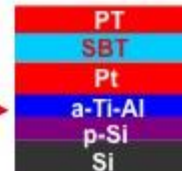
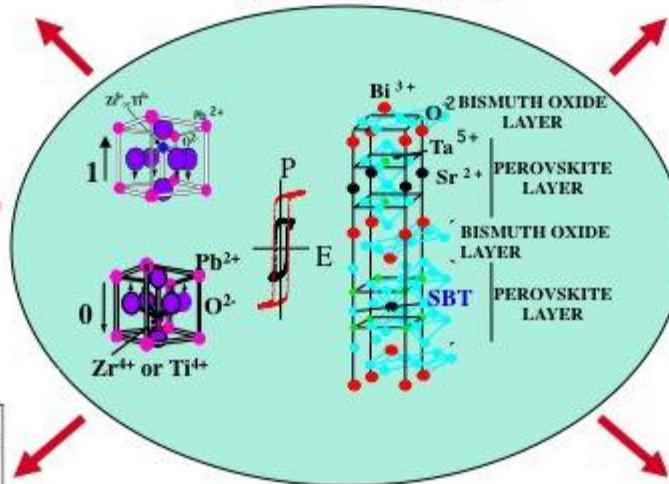
High-density FeRAM architecture
for Gb to Tb memories



Polarization fatigue, imprint, retention is controlled in PZT-based FE capacitors by using oxide electrodes



Polarization fatigue, imprint, retention controlled via control of oxygen vacancies at PZT/electrode interface



Polarization fatigue, imprint, retention is controlled in SBT-based FE capacitors even with Pt electrodes

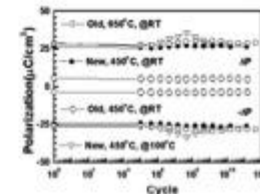
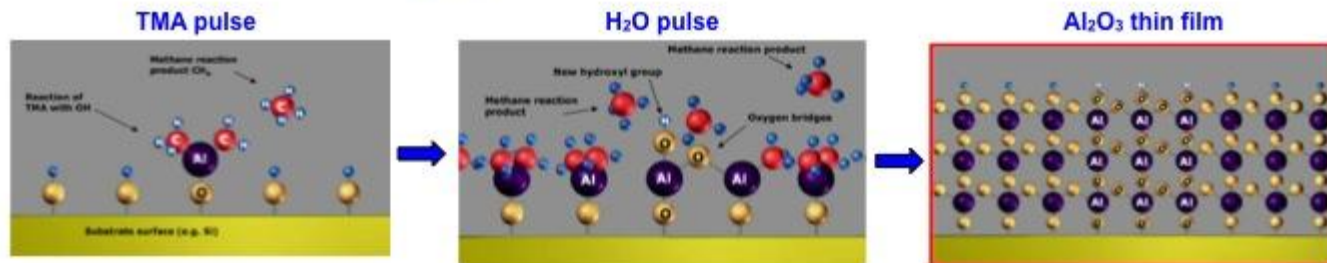


Fig 4 Liu et al

Atomic Layer Deposition (ALD)

Advance technology for thin film growth with
super uniformity and atomic scale controlled
thickness (conformal growth)

Self-limiting gas phase reaction



Source for Al_2O_3 :
 H_2O and $\text{Al}(\text{CH}_3)_3$ (TMA)
1 Å/cycle @ 300 °C

Source for TiO_2 :
 H_2O and TiCl_4
0.3 Å/cycle @ 300 °C

ANL-ALD Systems from Sundew Technologies
provide fastest film growth due to
Patented superfast valves



ALD System in ANL-MSD
200 mm wafer capability



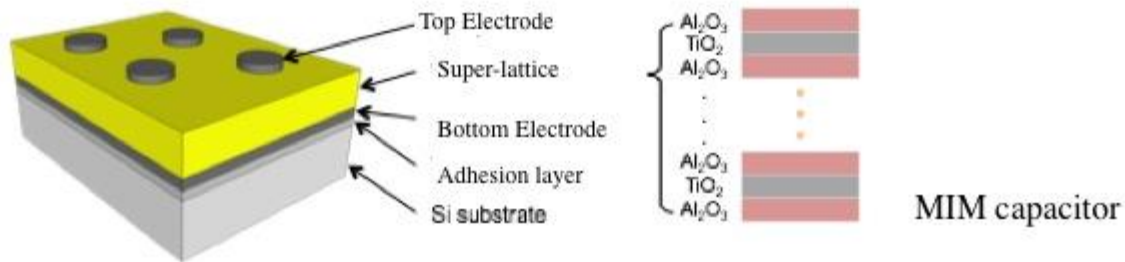
ALD System in ANL-CNM Clean Room
200 mm wafer capability
(UPR System at CNM)

(through Katiya /Auciello collaboration)

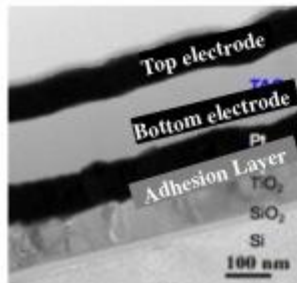


TiO_x/Al₂O₃ Superlattice Nanostructure

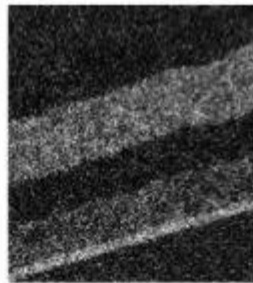
O. Auciello et al.
Patent Pending, 2012



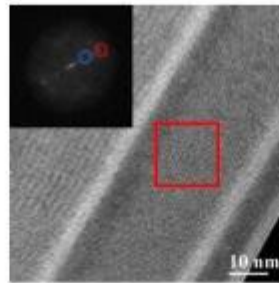
TEM



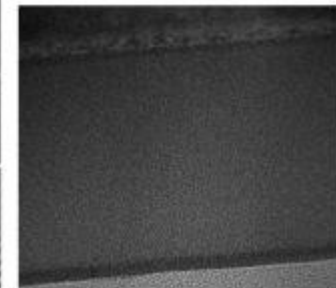
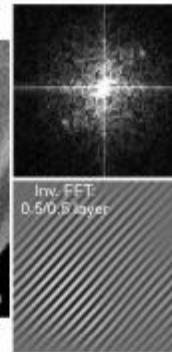
Oxygen mapping



HR TEM



C.D. Phatak, J. Hiller, D. Miller



N. Zaluzec, J. Hiller, D. Miller

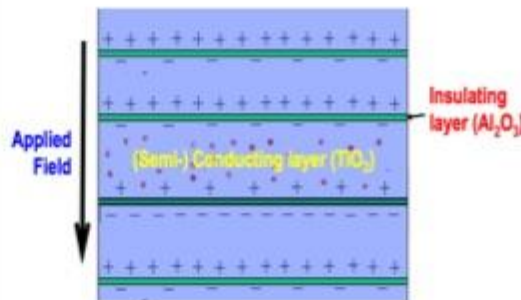
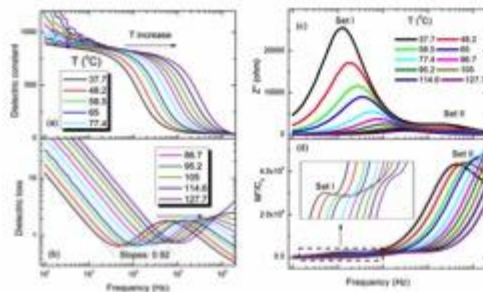


Maxwell-Wagner (MW) effect

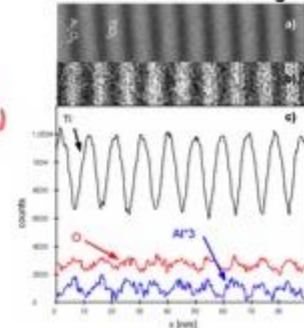
* MW effect: Charge carriers accumulation at heterogeneous semiconductor/insulator interfaces.

Capacitance is proportional to (# of carriers) \times (# of interfaces)

* Dielectric constant (k): TAO (150nm) = ~ 1000 , Al_2O_3 bulk = 9 (insulating), TiO_2 bulk = 40 \sim 100 (semi-conducting)



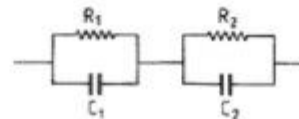
Cross Section TEM Images



EELS Analysis of $\text{Al}_2\text{O}_3/\text{TiO}_2$ Nanolaminates

A typical Debye-type relaxation (dipole re-orientation):
However, there are no dipoles in $\text{Al}_2\text{O}_3/\text{TiO}_2$ nanolaminates.

MW relaxation: When current passes through the multilayer structures, charged carriers (mainly **Oxygen vacancies**) can accumulate at the interface and cause the **Maxwell-Wagner relaxation**, also called Interfacial relaxation.



$$\epsilon^* = \epsilon' - i\epsilon'' = \frac{1}{i\omega C_0 Z^*} = \epsilon'_\infty + \frac{\epsilon'_s - \epsilon'_\infty}{1 + i\omega\tau} - i\frac{\sigma'}{\omega}$$

$$f = f_0 \exp\left(-\frac{U}{k_B T}\right) \quad \text{Activation energy from Arrhenius plot: } \sim 0.4 \text{ eV, oxygen vacancy}$$

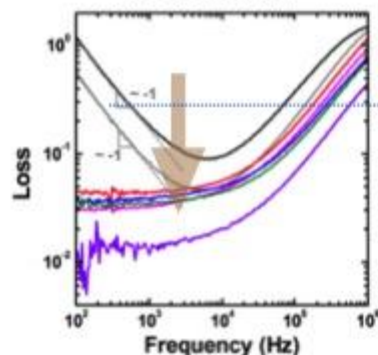
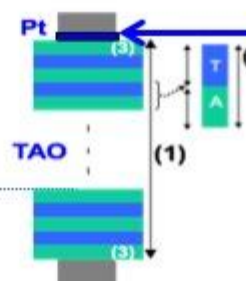
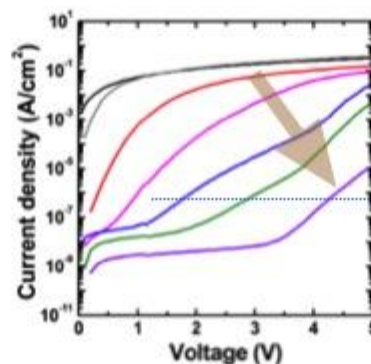
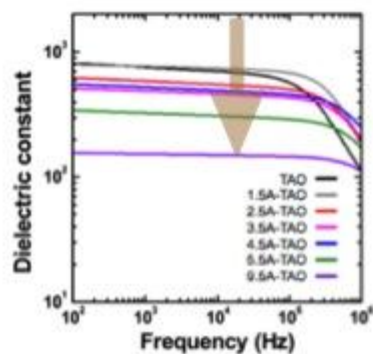
$$\epsilon'_\infty = \frac{1}{C_0} \frac{1}{\frac{1}{C_1} + \frac{1}{C_2}}, \quad \epsilon'_s = \frac{R_1^2 C_1 + R_2^2 C_2}{C_0 (R_1 + R_2)^2}, \quad \sigma' = \frac{1}{C_0 (R_1 + R_2)}, \quad \text{and } \tau = \frac{R_1 R_2 (C_1 + C_2)}{(R_1 + R_2)}$$



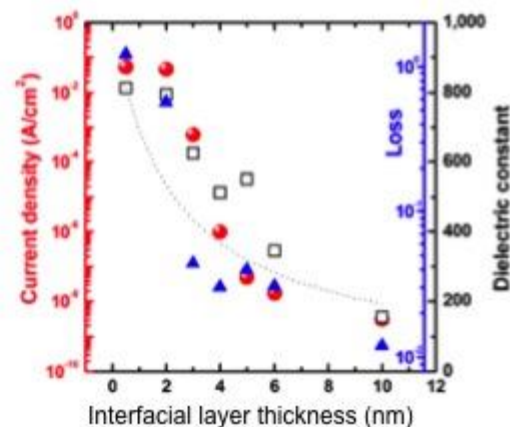
Minimize Leakage Approach (Patent Pending)

Approaches

- (1) Increase k and resistance
- (2) Oxygen vacancy control
- (3) Stop leakage path with oxide interface layer

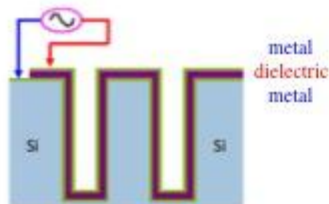


Stop Leakage Approach
 k (dielectric constant) \searrow
 D (loss) \searrow
 J (leakage current density) \searrow
 Y.Q. Wu et. al, Appl. Phys. Lett. 90,
 072105 (2007)



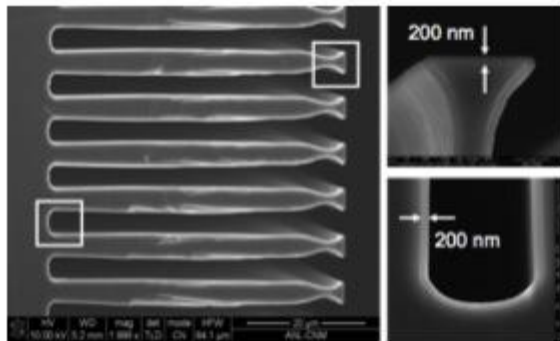
TAO Applications to High Capacitance Capacitors and Next Generation Nanoscale CMOS Devices

3-D High capacitance capacitor



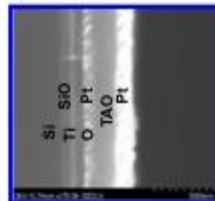
$$C = \frac{\kappa \epsilon_0 A}{t}$$

Capacitance increase
by area and κ



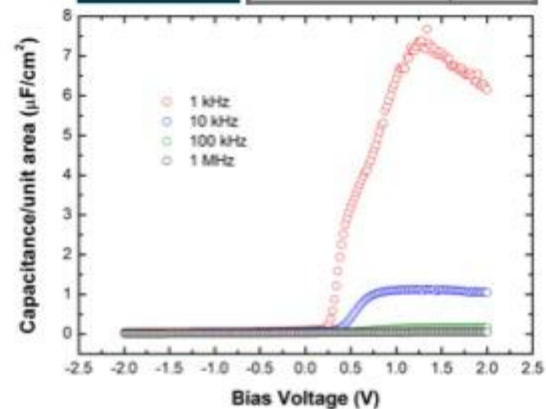
- $\text{Al}_2\text{O}_3/\text{TiO}_2$ grown by ALD
- Film shows conformal growth along with the morphology of 3D structure

• $8 \mu\text{F}/\text{cm}^2$ @ Si array trench



High-k gate oxide

| | | |
|--------------|--|------|
| TE | TAO thickness (nm) | |
| TAO (high-k) | Capacitance ($\mu\text{F}/\text{cm}^2$) @ 1 kHz and 2 V | ~ 10 |
| n-type Si | k | 210 |
| | EOT (nm) | 0.56 |



**UNIQUE MULTIFUNCTIONAL
ULTRANANOCRYSTALLINE
DIAMOND (UNCD) FILM
TECHNOLOGY**

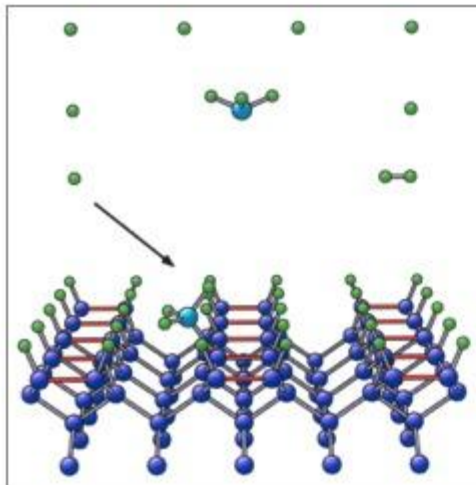


Fundamentals of UNCD Films



CH₄/H₂ Chemistry for MCD Growth

1960's to present: Unsuccessful for Large Scale Commercialization



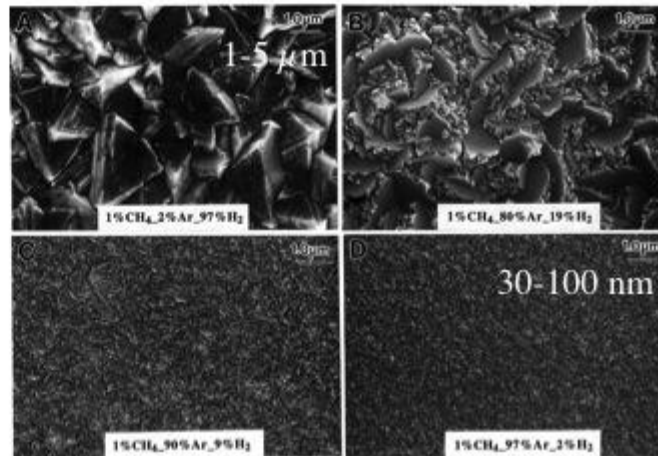
Growth Conditions

- * 1% CH₄, 99% H₂ @ 100 Torr
- * 600-800 °C substrate temperature

H abstraction from
Diamond surface to insert
methyl group results in
high activation energy:

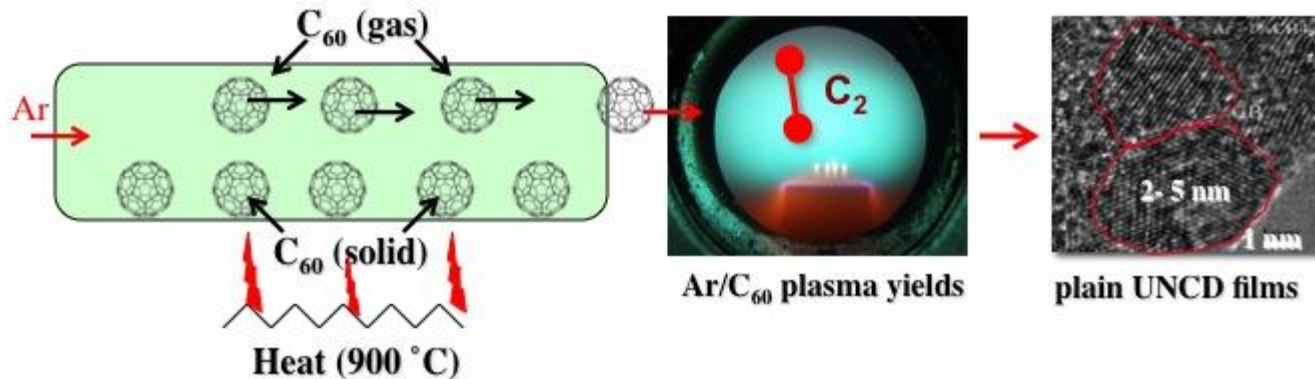
$$\Delta G = -20-30 \text{ kcal/mole}$$

- Low nucleation density:
(10⁴-10⁸ /cm²)
- Columnar growth
- Large grain size (1-5 μm)
- High surface roughness:
(≤ 1 μm)



ARGONNE'S UNCD Growth Process Using C_{60} Molecules Carried into MPCVD Chamber: Scientific Success, But !!!!!

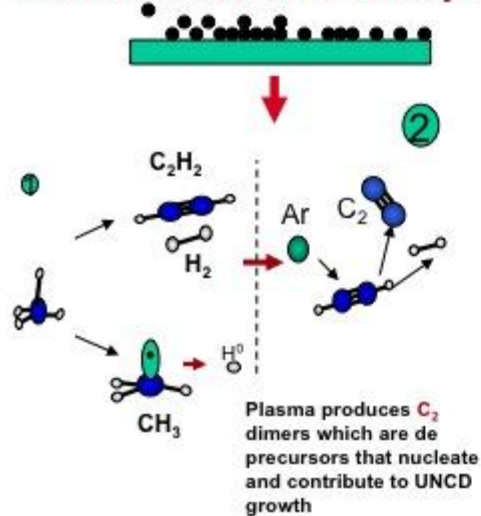
- Expensive
- Complicated
- Dirty oven connected to clean MPCVD chamber
- Difficult to scale up to cover large area substrates



ARGONNE's UNCD Film Synthesis Approach

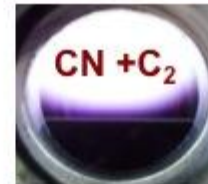
- UNCD films are grown using a plasma containing Ar (99%) /CH₄ (1%) → (Ar/C₂H₂/H₂)

Substrate is seeded with nanocrystalline diamond

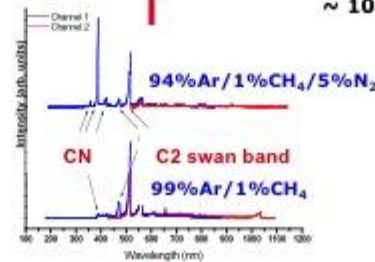


The C₂ dimers form sp³ chemical bonds on the substrate surface:

- Low activation energy (6 Kcal/mol)
- High re-nucleation density (10¹⁰ /cm²)



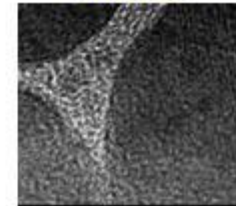
Ar/CH₄/N₂ plasma yield N-UNCD films



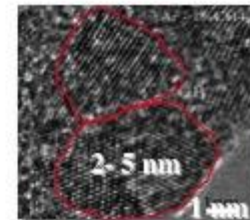
Ar/CH₄ plasma yield plain UNCD films

Auciello et al.
APL 79 (2001)1441

HRTEM



Nitrogen-doped UNCD films have ~ 10 nm grains and 1-2 nm GB

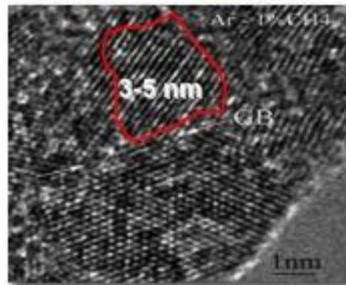


Plain view TEM of UNCD film
3 - 5 nm grains/0.4 nm GB

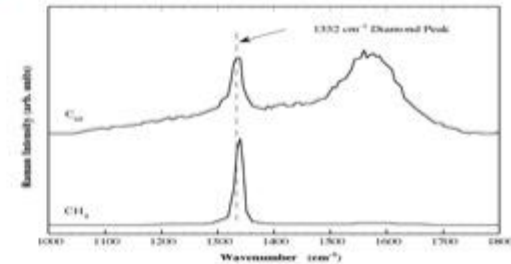
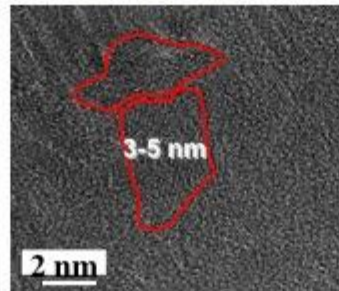
Auciello et al.
Diamond & Related Mater.
vol. 10 (2001) 1952

Nanostructural and Chemical Bonding Characterization of UNCD Films

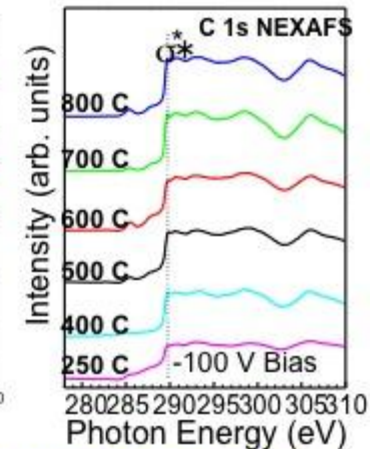
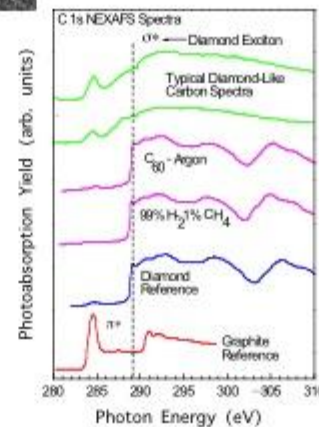
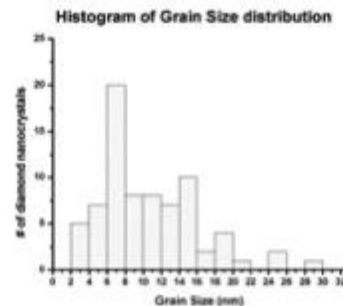
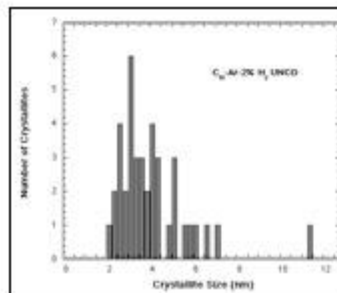
800 °C UNCD



400 °C UNCD



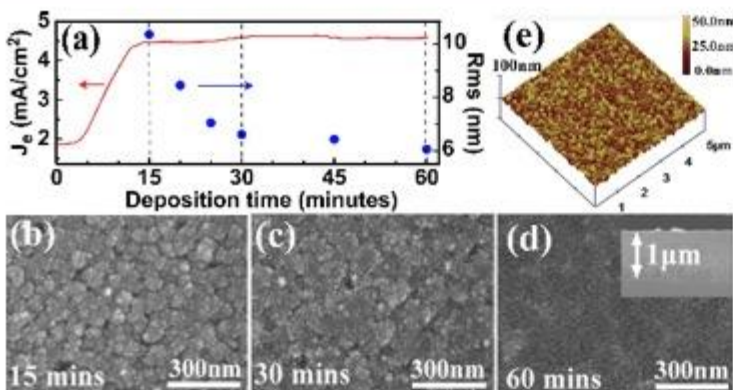
UV Raman spectra of UNC and MCD films grown at 800 °C



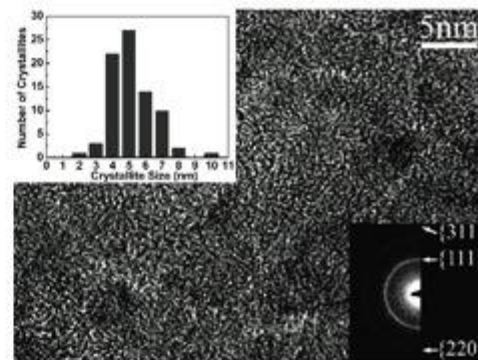
(NEXAF) spectra of UNCD and other carbon-based films
(Terminelo/ Carlisle/Gruen/Krauss/Auciello (1996-present))



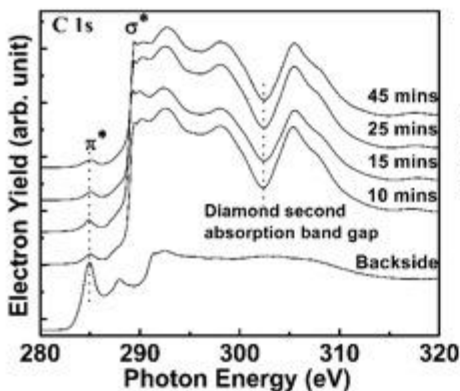
BEN-BEG of UNCD Films: Current vs Deposition Time and Correlation to Surface Morphology, HRTEM and NEXAFS Studies



Current and rms roughness vs deposition time



HRTEM studies show UNCD nanostructure plus grain size statistics of UNCD



NEXAFS shows diamond/UNCD signature

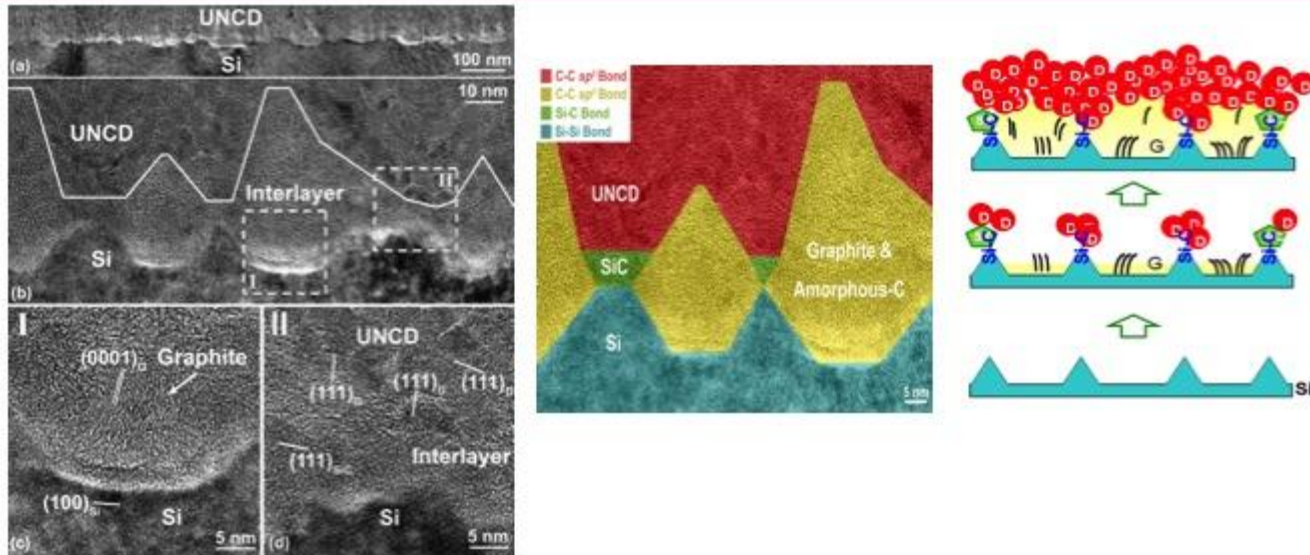


4 "Si wafer coated with uniform UNCD film (needs R&D to grow uniform UNCD films on 6" and 8" wafers)

Chen/Auciello et al.
Appl. Phys. Lett. **92** (2008)



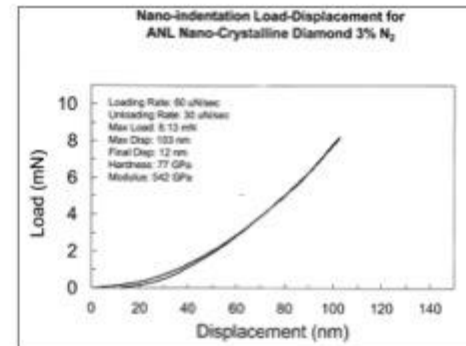
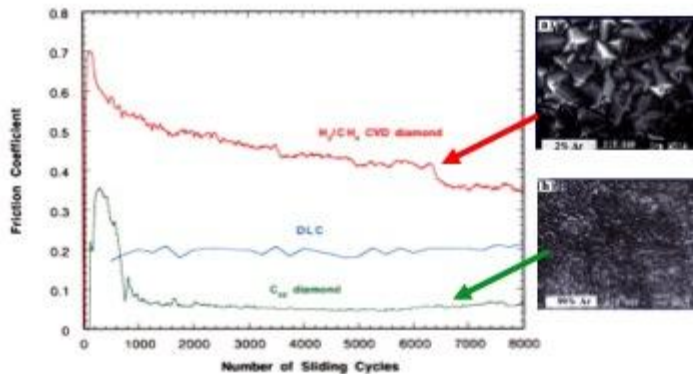
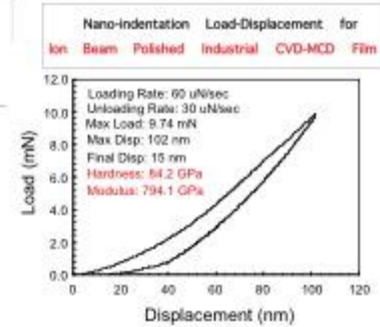
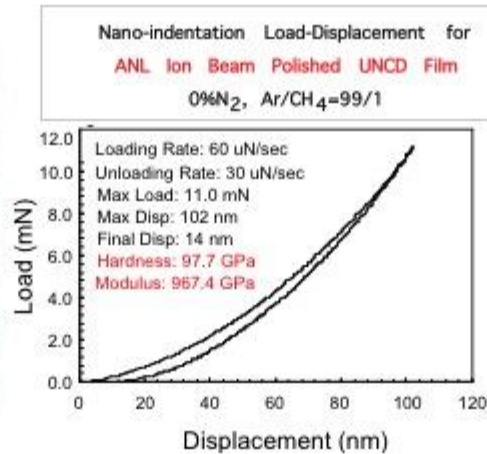
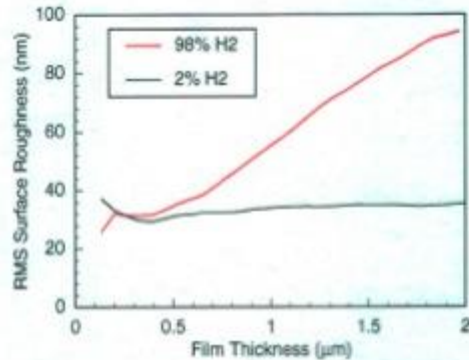
HRTEM Studies of Nucleation Layer and UNCD Film on Si Surface Pretreated with H-Plasma With Bias + BEN-BEG



- SiC phases are formed at the peaks of the Si surface triangular profile due to the active unsaturated Si bond and the enhanced local electrical field.
- The UNCD grains preferentially grow at the peaks of the triangular substrate surface profile and rapidly cover the a-C and oriented graphite phases formed in the valley of the surface profile.



Properties of UNCD



Hardness of nitrogen-doped UNCD films



Summary of Multifunctional Properties of UNCD Films

- **Electrical Conductivity**
N-type UNCD (N in grain boundaries) ($\sim 260 \Omega \cdot \text{cm}^{-1}$ at RT!) tunable
B-doped UNCD (B-substitutional in diamond lattice (**metallic**))
- **Mechanical**
Hardness (**98 GPa**), Young modulus (**998 GPa**) fracture strength ($\sim 5 \text{ GPa}$)
X-diamond (**100 GPa**), X-diamond (**1100 GPa**)
- **Tribological**
Low friction ($\sim 0.02-0.04$ *in air*), High wear/corrosion resistance
Low *Stiction*, Smooth, Conformal Coating
RMS roughness ($\sim 4-20 \text{ nm}$ as deposited)
- **Low-Temperature Deposition**
 $\sim 0.2-0.4 \text{ um/hr}$ at $350-400^\circ \text{C}$
- **Surface Micromachining**
UNCD-MEMS/NEMS
- **Field Emission**
Low threshold ($\sim 2 \text{ V}/\mu\text{m}$), stable
- **Electrochemical**
Wide working potential (**4 eV**) biocompatible
- **Surface Chemistry**
Express DNA, Proteins on UNCD surface



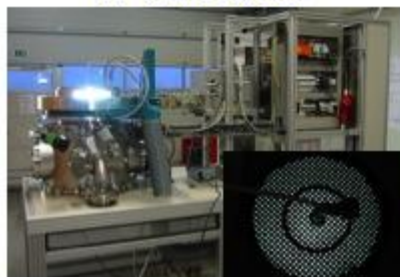
Selected Properties of Si, SiC, and Diamond

| Property | Silicon | Silicon Carbide | Diamond |
|--------------------------------|---------|-----------------|-----------|
| Lattice Constant (Å) | 5.43 | 4.35 | 3.57 |
| Cohesive Energy (eV) | 4.64 | 6.34 | 7.36 |
| Young's Modulus (GPa) | 130 | 450 | 1200 |
| Shear Modulus (GPa) | 80 | 149 | 577 |
| Hardness (kg/mm ²) | 1,000 | 3,500 | 10,000 |
| Fracture Toughness | 1.0 | 5.2 | 5.3 |
| Flexural Strength (MPa) | 127.6 | 670 | 2944 |
| Friction Coefficient | 0.4-0.6 | 0.2-0.5 | 0.01-0.04 |
| Relative Wear Life | 1.0 | | 10,000 |



Tools for Growth of UNCD Films For Military and Commercial Applications

11" IPLAS System

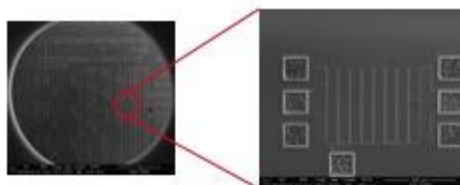


New Lambda MPCVD System at ANL-CNM

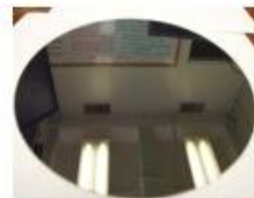


Only MPCVD for UNCD and carbon films synthesis in a clean room

ADT Commercializes Large Area UNCD Films via HFCVD



UNCD (400 °C) Coating on
150 mm Si wafer
($\pm 5\%$ thickness uniformity)



300 mm Si Wafer coated with UNCD Film
($\pm 3\%$ film thickness uniformity)

2003 R&D 100 Award
ANL/UNCD-IPLAS
technologies

2008 R&D Award
UNCD Seals

2006 FLC Award to
O. Auciello / J. Carlisle for
Technology UNCD transfer
to the Market

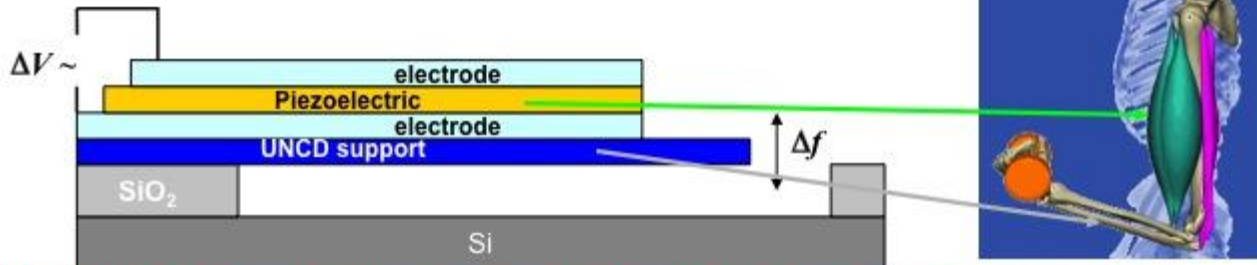
ADVANCED DIAMOND TECHNOLOGIES

O. Auciello/J.A. Carlisle
(Founders-2003)
J. Yerger (CEO)



Hybrid PZT/UNCD MEMS/NEMS Integration

Hybrid Piezoelectric/UNCD unimorph assembly:

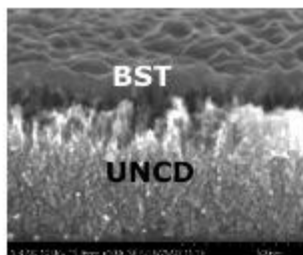


PZT/UNCD integration has several potential piezoelectric applications, however, there are scientific and technological barriers to MEMS applications:

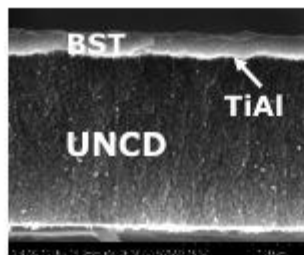
- UNCD growth need to be optimized for uniform thickness (**achieved 5% uniformity on 150 mm wafer**)
- Interface delamination between metal electrode-UNCD (**under control**)
- Integration of piezoelectric (e.g., PZT) and UNCD: oxidation of diamond (**Oxygen diffusion barrier developed**)
- Micro and nano fabrication for PZT-UNCD structures (**demonstrated**)
- Piezoelectric actuation of hybrid PZT/UNCD micro/nano cantilevers (**demonstrated**)



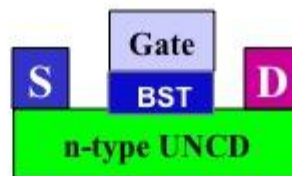
Oxide/UNCD Integration FOR MEMS/NEMS/Electronics Multifunctional Devices



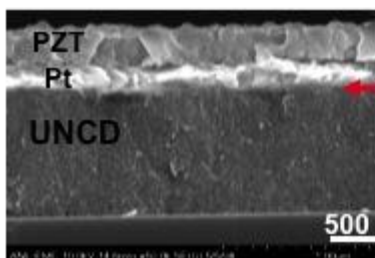
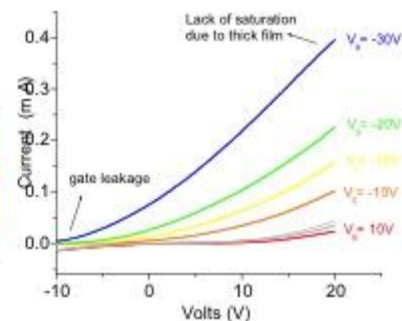
Ba_xSr_{1-x}TiO₃/UNCD results in diamond etching



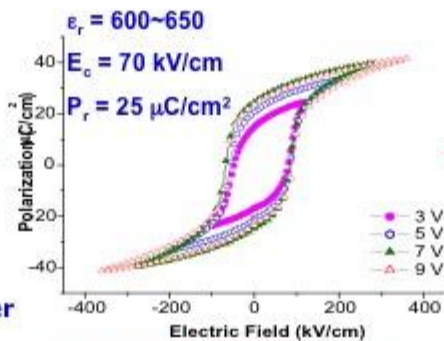
BST/TiAl/UNCD: TiAl layer enables oxide/diamond integration



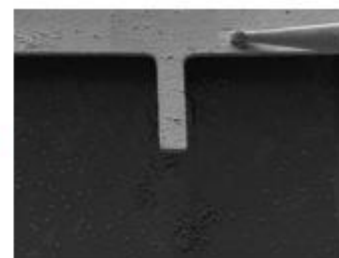
First BST/UNCD hybrid MISFET



PbZr_xTi_{1-x}O₃/Pt/TiAl/UNCD: TiAl layer enables Piezo/ diamond integration



First Pt/PZT/Pt/TiAl/UNCD capacitor with excellent properties demonstrated



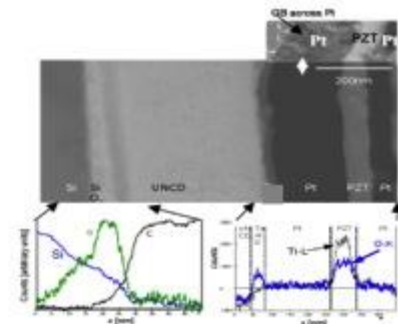
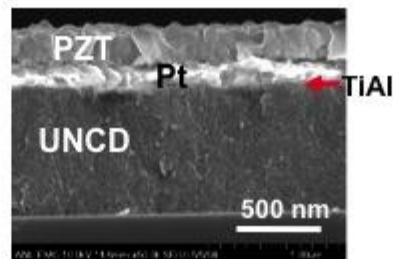
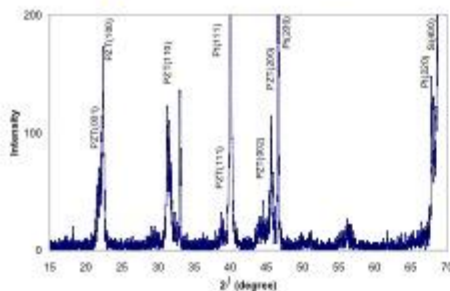
First PZT/UNCD hybrid resonator
1 BILLION CYCLE DEMONSTRATED



Pb(Zr_{0.47}Ti_{0.53})O₃ (PZT) Film Synthesis and PZT/UNCD Integration Strategies for Piezoactuated MEMS/NEMS

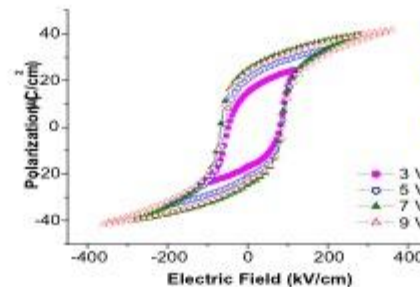
Materials and Device Performance Characterization

Synthesis and Properties of PZT films



PbZr_xTi_{1-x}O₃/Pt/TiAl/UNCD enables robust oxide Piezoelectric/ diamond integration

First Pt/PZT/Pt/TiAl/UNCD capacitor with excellent properties demonstrated

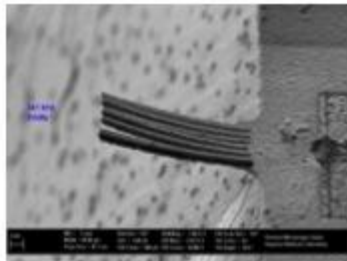


$\epsilon_r = 600 \sim 650$
 $E_c = 70 \text{ kV/cm}$
 $P_r = 25 \text{ } \mu\text{C/cm}^2$

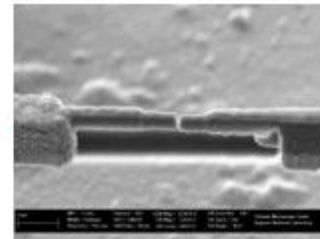
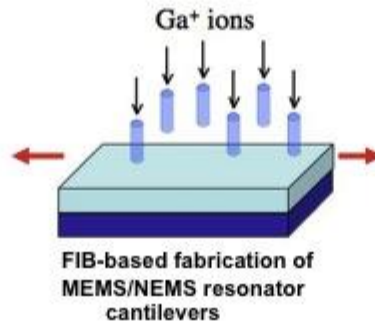
Auciello et al
 APL (2007)



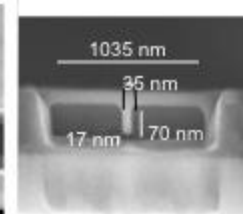
Hybrid PZT/UNCD Resonant Cantilevers for Piezoactuated MEMS Energy Harvesters / NEMS Logic System



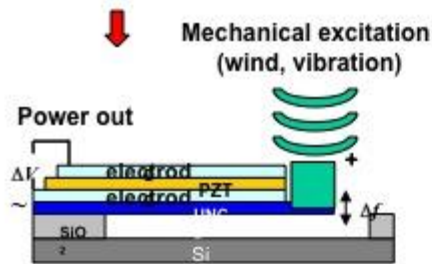
UNCD cantilevers vibrating at 1 MHz with 3 Volt, 1 billion cycles +



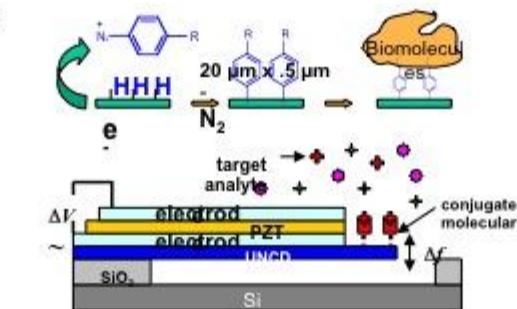
UNCD horizontal cantilever Vibrating at 1 MHz with 1 Volt, 1 billion cycles +



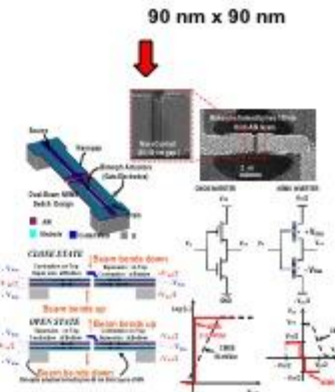
Vertical UNCD nanoswitch



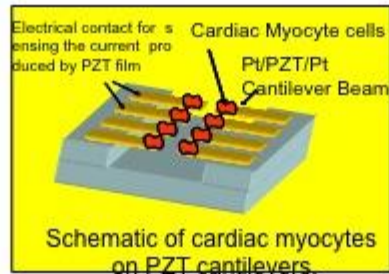
Energy Harvester based on Hybrid high-stiffness UNCD cantilever and Piezo generating power generation



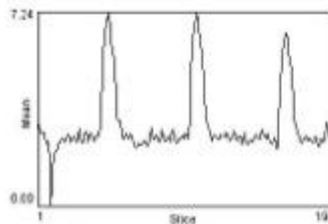
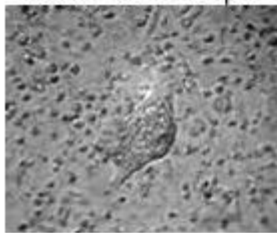
Piezoactuated hybrid piezo/UNCD biosensor



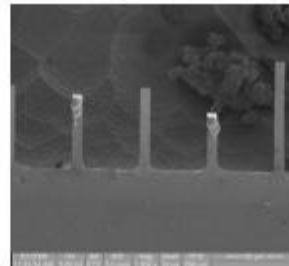
Cardiac Cells Mediated Actuation of Piezoelectric Micro/Nanocantilevers for Biopower Generation



Cardio myocyte
length: 50 -100 μ m
diameter: 10-25 μ m



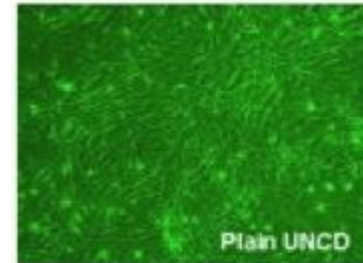
Intensity graph of the beating of cardiac myocyte



Cell suspension dropped onto protein coated UNCD cantilever array chip integrated with Pt/PZT/Pt, resulting in randomly attached cells to cantilever, and cultured.

Preliminary power = 1-3 μ W

(In collaboration with R. Bashir,
Purdue Univ)



Mouse Embryonic Fibroblast grown on UNCD surface



ANL Work on Development of UNCD as Dielectric layer for RF MEMS Switches

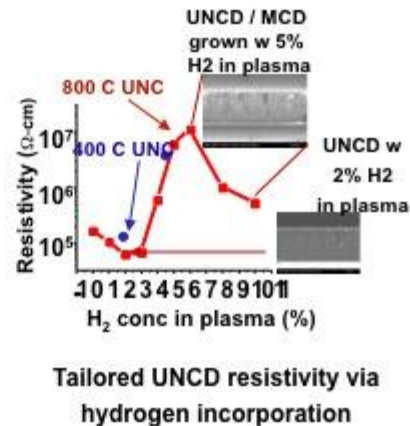
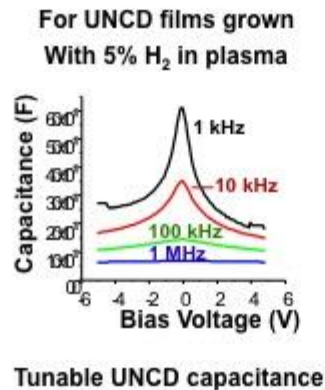
Development of low temperature UNCD films as RF MEMS switch dielectrics

Task

Development of processes to tailor dielectric properties of UNCD films and measurement of UNCD dielectric properties for optimization as dielectric layer in RF MEMS Switches



Measurements



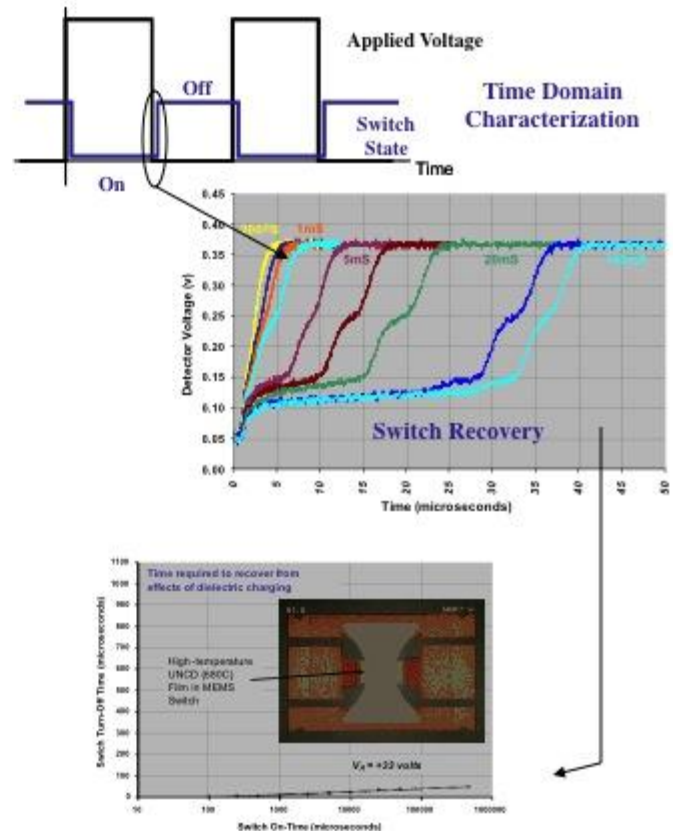
Milestones (April 2008)

Development of optimized LR and negligible stiction LT UNCD dielectric for application as dielectric layer with controlled leakage for RF MEMS switches



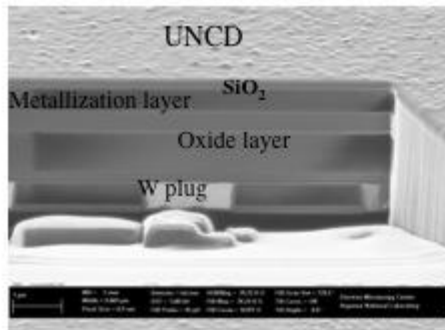
UNCD Charging Characteristics

- Physics of dielectric charging in UNCD is fundamentally different from conventional MEMS dielectrics (SiO_2 or Si_3N_4)
- Charging in UNCD occurs extremely quickly
 - Time constant on the order of $100\ \mu\text{s}$ (compared to 10-100 s for silicon dioxide)
 - Device fails very quickly
- However, discharging process is also very fast
 - Device recovers very rapidly
- In most radar applications, required on-time of switch is less than 10-100msec
 - This enables the switch to fully recover within the allotted switching time of the MEMS switch (typically $< 50\ \mu\text{s}$)
- Completely new paradigm in device operation
 - Fails quickly, but recovers very quickly
 - **Patent pending**
- Concept has been demonstrated/measured in MEMS switches fabricated with 400°C UNCD devices.

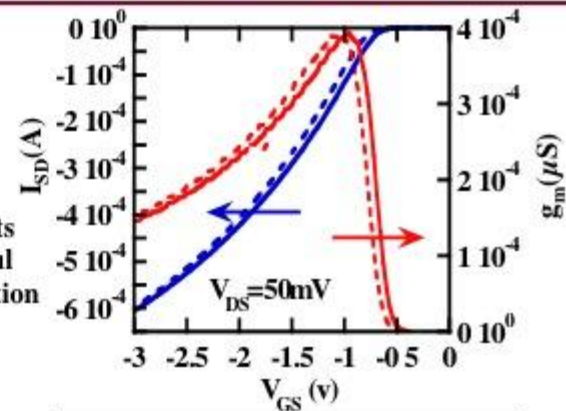


UNCD CMOS Integration (DARPA-HERMIT Program)

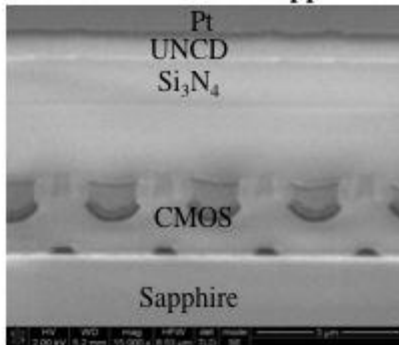
FIB cross-section image of UNCD/CMOS-Si



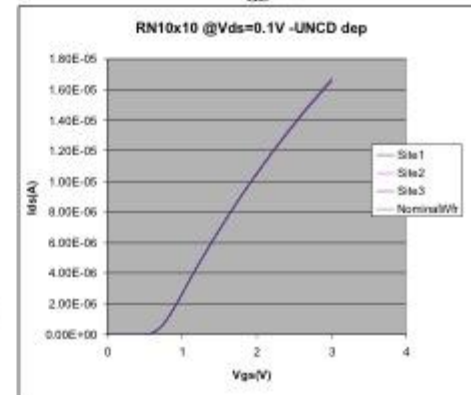
Electrical measurements demonstrated successful UNCD/Si-CMOS integration



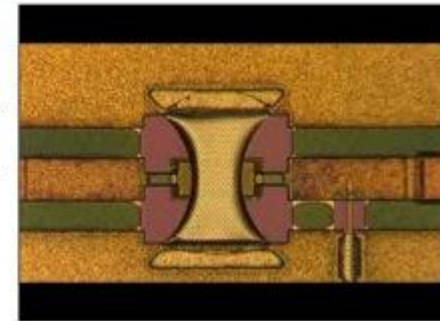
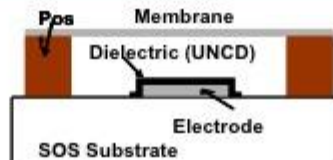
FIB cross-section image of UNCD/CMOS-Sapphire



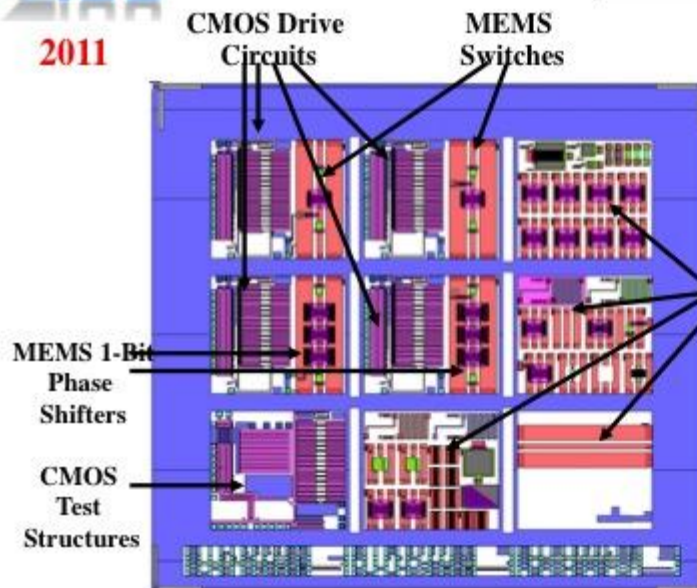
Electrical measurements demonstrated successful UNCD/SiO₂Sapphire CMOS-integration



RF UNCD-MEMS Switches/SOS-CMOS Integration

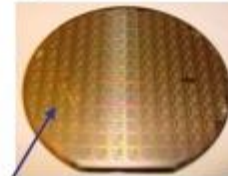


50 Billion Cycles Demonstrated



MEMS Test Structures

Peregrine SOS CMOS Wafer



- Die size
 - 10.1 mm x 10.1 mm
- Die includes
 - CMOS driver circuits
 - CMOS test structures
 - MEMS switches and 1-bit phase shifters
 - MEMS test structures
- 150mm wafer contains 130 dies

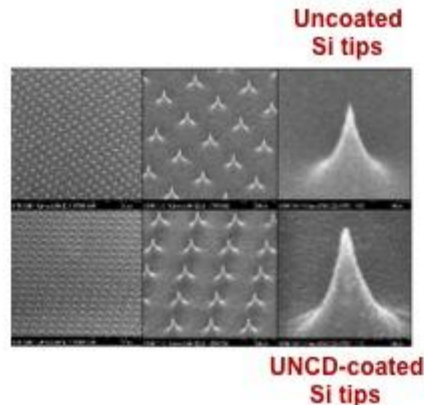
DARPA-HERMIT Program (2005-2011)
Product in Prototype Stage
Needs funding to bring to market



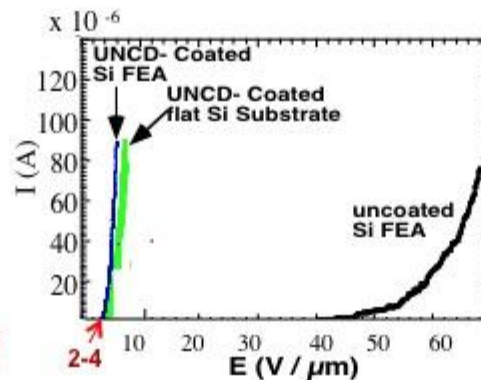
Application of UNCD Films to Field Emission Devices

Current contract with Goddard Space Center to develop UNCD field emission cathodes for mass spectrometers for deep space exploration

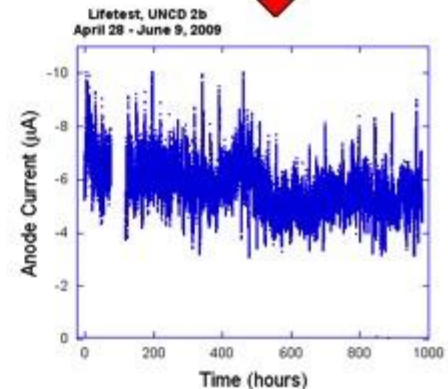
1000 "REAL" hrs stable emission demonstrated



Large Si tip array coated with UNCD film for field emission, using bias-enhanced growth



UNCD surfaces exhibit \ll threshold voltage for field emission ($2-4 V/\mu m$) than Si ($40-50 V/\mu m$) or metal surfaces and UNCD flat surfaces exhibit as low FE field as UNCD on tips



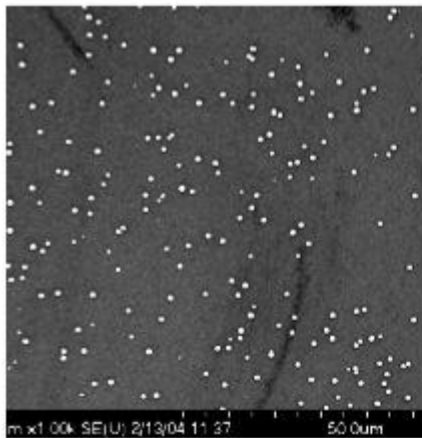
UNCD-coated Si tip array exhibited stable emission for ~1000 hrs in $\sim 10^{-6}$ Torr

Auciello/Carlisle et al. APL 94 (2003) 4079
Krauss/Auciello et al., JAP 89 (2001) 2958

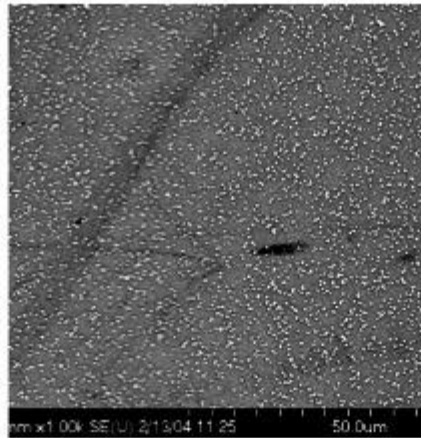
Auciello/Sumant/Getty
(Goddard Space Center-
Work in progress (2010)



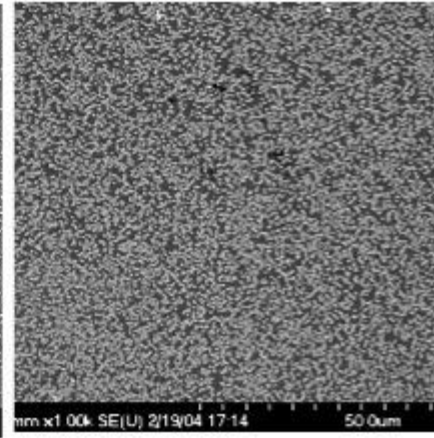
Fuel Cell Electrodes Based on Pt Nanoparticles Embedded on Electrically Conductive NUNCD or BUNCD Film Surfaces



100 s



400 s



600 s

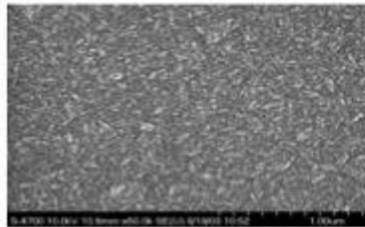
Galvanostatic electrodeposition of Pt was performed in 1 mM K_2PtCl_6 + 0.1 M HClO_4 using a current density of 0.4 mA/cm². We are able to control the particle size and distribution density by adjusting the deposition time and current density. Using pulse deposition we are able to deposit Pt particles with size less than 20 nm.



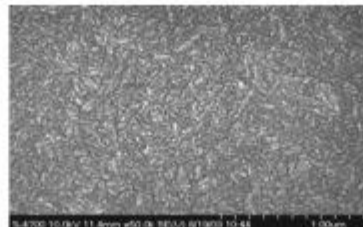
Electrochemical Stability of UNCD vs Classy Carbon

Electrode Potential: 2.5 V vs. Ag/AgCl in 0.1 M HClO₄.

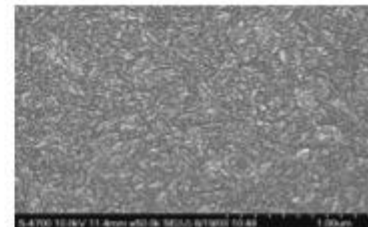
UNCD



Before

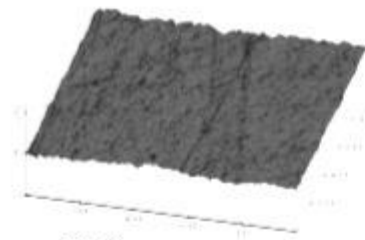


10 min.

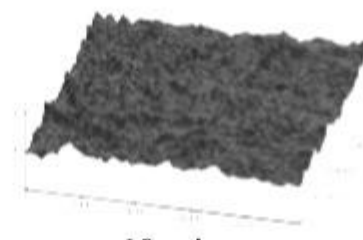


30 min.

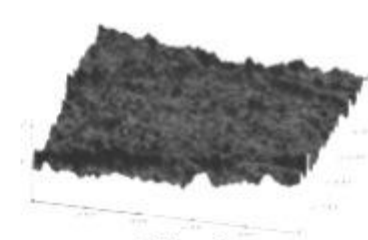
Glassy Carbon



Before



10 min.



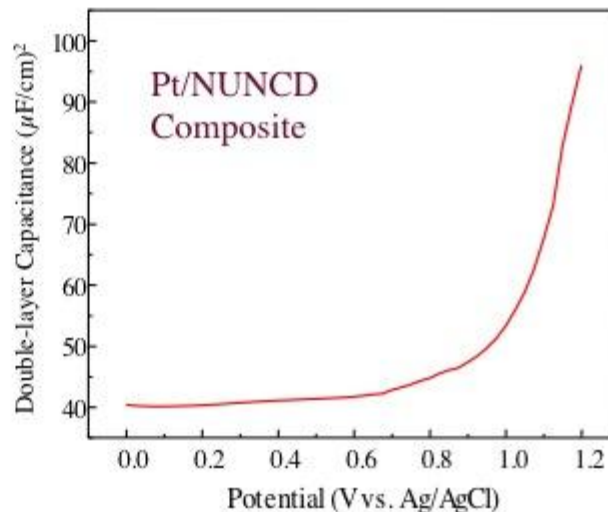
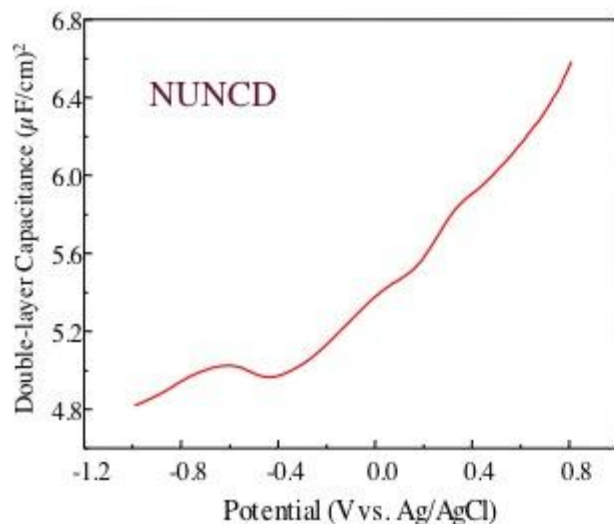
15 min.

Question: Is the difference between the chemical and electrochemical stabilities of UNCD vs. glassy and other carbons due to the directionality of sp² vs. sp³ bonding and/or bond strength?

- Carbon black: particle size: < 5 nm to > 300 nm
- UNCD: grain size: 3-5



UNCD vs Pt Nanoparticle-UNCD Electrode Double Layer Capacitances

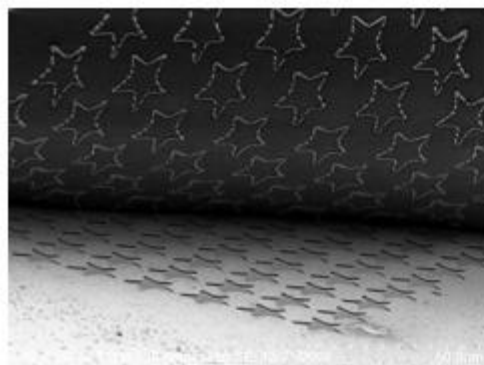
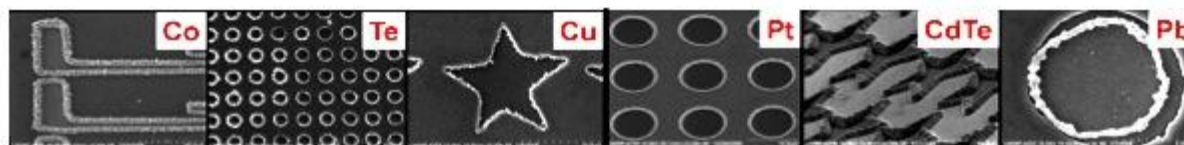
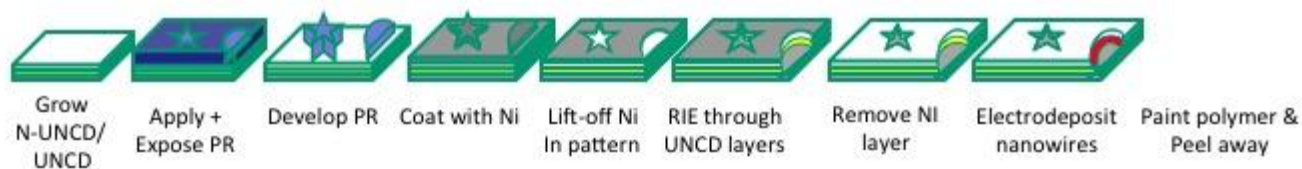


The double layer capacitance of the Pt/UNCD composite electrode is one order of magnitude higher than that of plain UNCD.

Auciello / Sumant, Diamond and Related Materials (Invited Review)19 (2010) 699



Development of UNCD/N-UNCD Multilayers as Reusable Template for Electrochemical Growth of Nanowires



D.A. Dissing, E. A. Terrell, D. B. Seley, M. P. Zach
Dept. of Chemistry, University of Wisconsin – Stevens Point

A. V. Sumant,¹ R. Divan,¹ S. Miller,¹ O. Auciello,^{1,2}

¹Center for Nanoscale Materials, ²Materials Science Division
Argonne National Laboratory

Advanced Materials (2011)



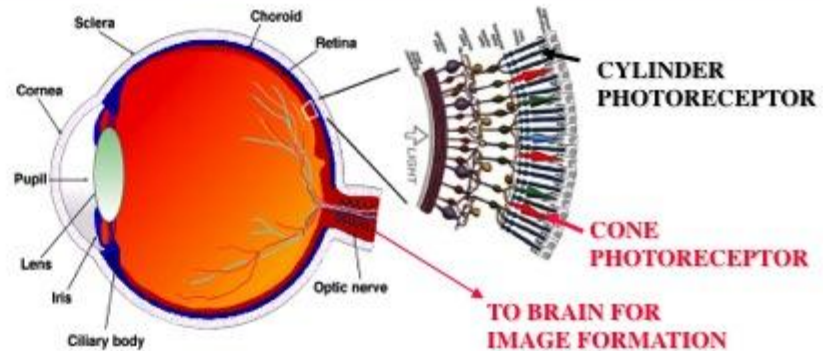
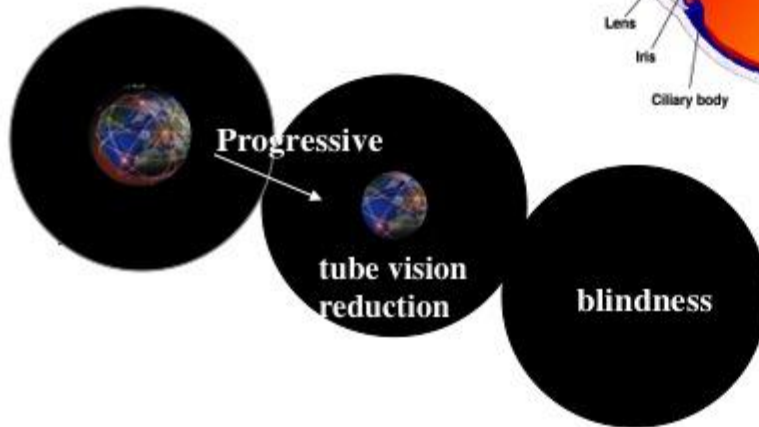
Biomedical Applications of UNCD Films



Towards an Artificial Retina for the Blind!....

**RETINA DEGENERATION:
A GLOBAL PROBLEM!.....**

About 25 million people worldwide



**Genetically-induced death of
Photoreceptors leads to**

2009 R&D 100 Award

2009 R&D 100 Top Editor's Choice Award

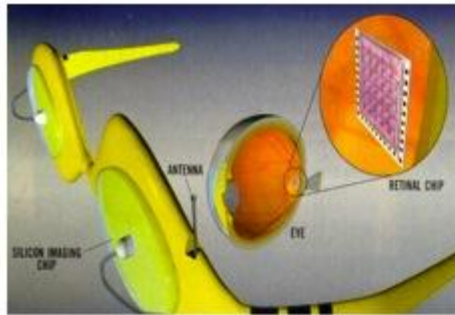
**Department of Energy
Office of Biological and Environmental Research
Medical Sciences Division**

**University of Southern California(Doheny Eye Institute)
North Carolina State University, Univ.California-Santa Cruz, CALTECH
Argonne, Lawrence Livermore, ORNL, Los Alamos, Sandia National Labs.
Second Sight (Industrial Partner)**

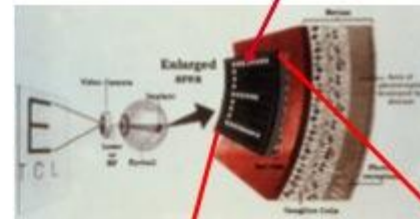


Artificial Retina Based on Implantable Microchip

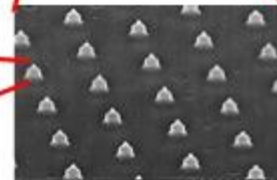
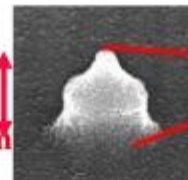
ANL's UNCD hermetic, bio-inert coating technology enables implantation of Si-based microchip onto the human retina via protection of Si from chemical attack by the eye's saline solution.



CCD camera on glasses capture image and transmits it via RF to microchip implanted on retina. Microchip sends electrical pulses to retina and from there to brain via optical nerve to restore vision



$1 \mu\text{m} = 0.0001 \text{ cm}$



High-conductivity N-Doped UNCD microtips could be used for corrosion resistant electrode array



MEMS retina adaptable electrodes

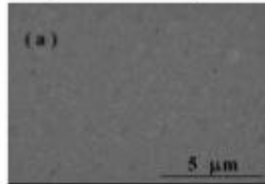
Xiao/Auciello et al.

J. Biomedical Materials 77B (2) (2006) 273

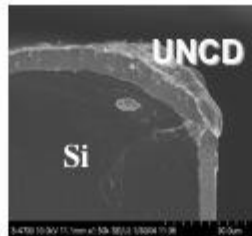
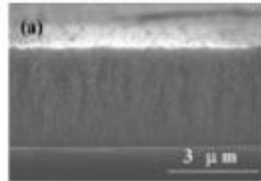


Research on Hermetic UNCD Coatings : Optimization of Insulating Properties

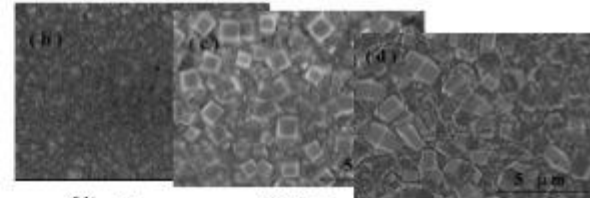
Hydrogen incorporation into grain boundaries satisfy dangling bonds resulting in reduction of leakage current, but need to keep hydrogen incorporation low to yield UNCD structure



Plain UNCD and 1% H



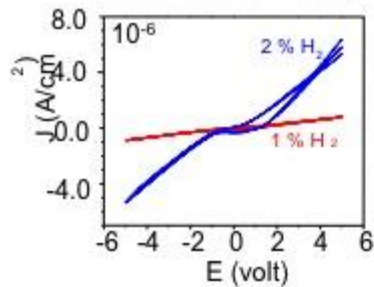
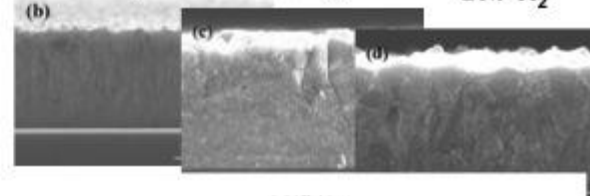
Encapsulating UNCD film grown on "swizzle"-like Si substrate with 1% H in Ar/CH₄ plasma



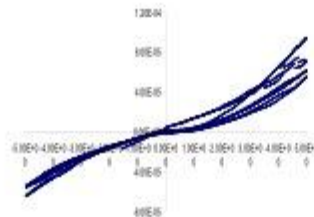
2% H₂

10% H₂

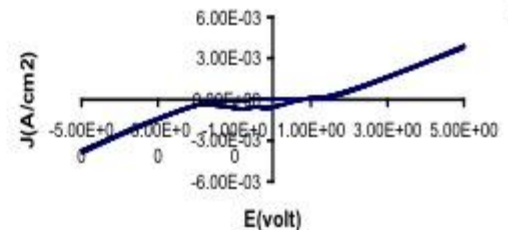
20% H₂



Low leakage in saline for flat UNCD films



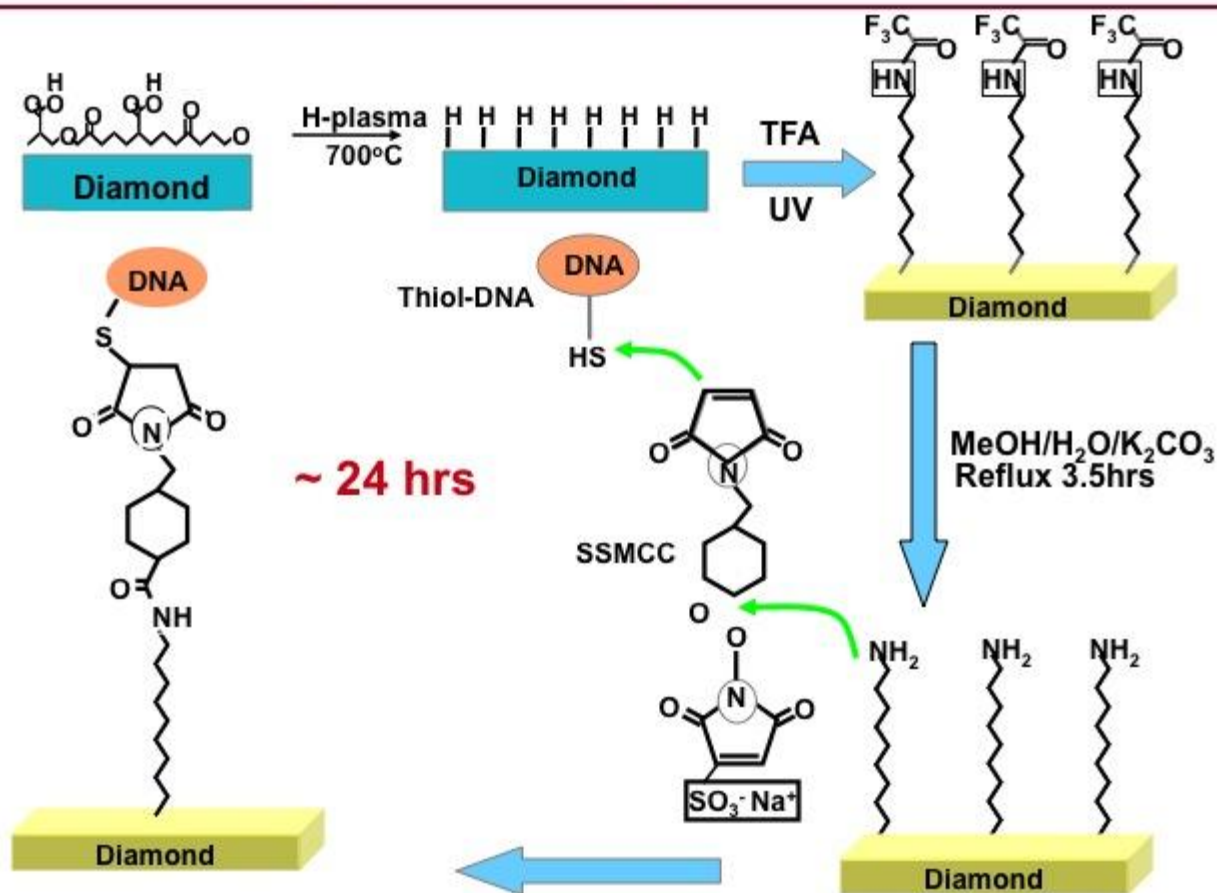
Intermediate leakage in saline for encapsulating UNCD films on "swizzle"-like Si substrates



High leakage in saline for flat UNCD films with relatively high H₂ in plasma



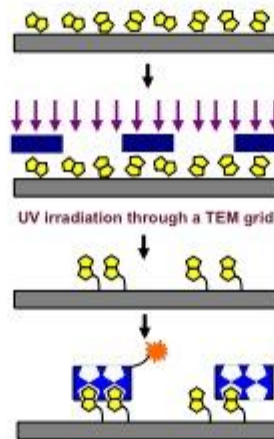
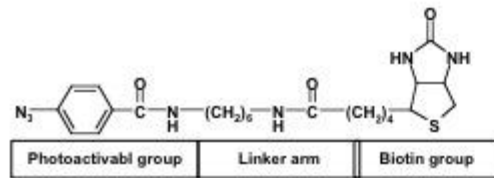
Chemical Conditioning Covalent Linking of DNA to Diamond Surface



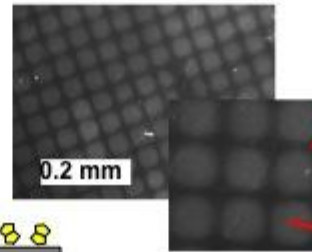
PROTEIN PATTERNING ON UNCD VIA PHOTOBIOITIN ACTIVATION

Selective covalent immobilization of biotin

**Needs Funding
To develop Biosensors**

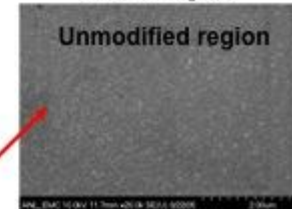


Fluorescence Microscopy

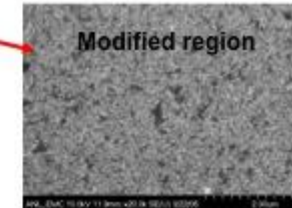


SEM images

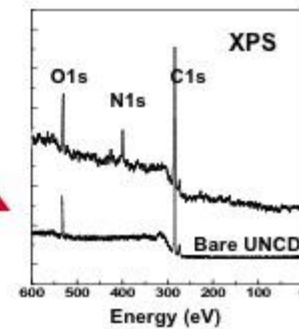
Unmodified region



Modified region



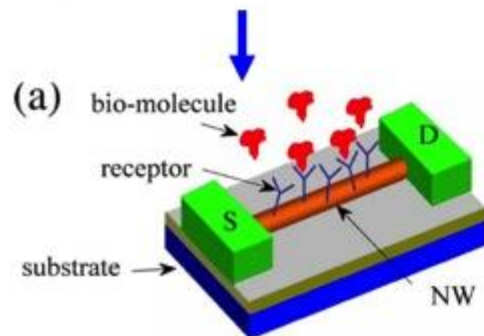
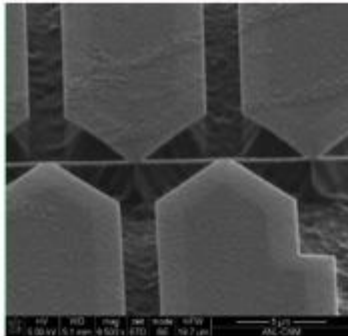
100 by 100 μm
25 μm spacing



Future... Nanoscale patterning

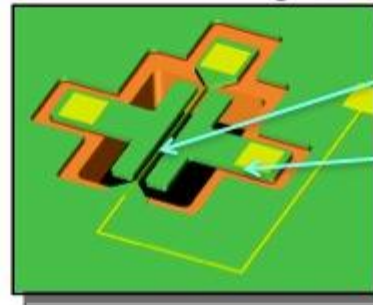


UNCD nanowires: Possible Applications



Studies of interaction of bio-molecules with diamond nanowire and development of sensors with increased sensitivity and new functionality

Nonlinear NEMS magnetometer



Current generated by Lorentz force on electrons in a nanowire in the presence of an external magnetic field

Drive electrodes

Nonlinear NEMS magnetometer

- Does not require integration with magnetic materials or micro-magnets
- Compatible with CMOS
- Can be combined into a compact three-axis device to measure gradients
- Consume little power during operation
- Reduction in size should allow us to achieve good spatial resolution.

A.V. Sumant¹, L. Ocola¹, D. Wang², D. Lopez¹, O. Auciello^{1,3} and D. Mancini¹

¹Center for Nanoscale Materials, ³ Materials Science Division
Argonne National Laboratory

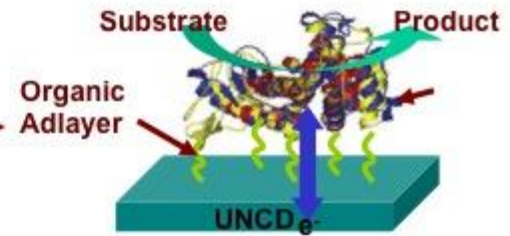
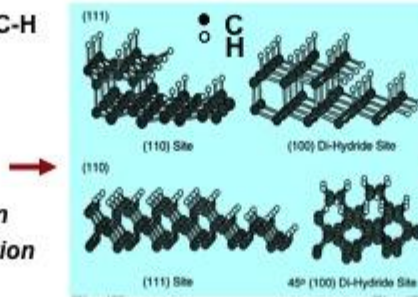
² Department of Physics, University of Puerto Rico



UNCD Films as Platform for Developmental Biology: A New Frontier

- **H-terminated diamond surface**

- Inherently low reactivity of C-H bonds
- Radical reactions — the general approach
 - Plasma (O_2 , NH_3) treatment
 - Photochemical reaction
 - Thermochemical reaction



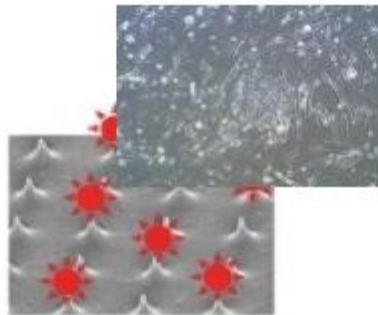
- **UNCD plays a dual role**

- Robust support for biomolecules
- Electrochemical signal transducer

Stem Cell Growth on UNCD Surface: New Platform for Stem Cell Research

Science

- Understand growth mechanism
- Understand stem cell/UNCD interface
- Explore possible stem cell differentiation
- into specific cells on UNCD surfaces
- Investigate cell/UNCD interface for electrical, chemical, bio communication with live cells in biological systems



H9 cells grown on UNCD-coated quartz dish

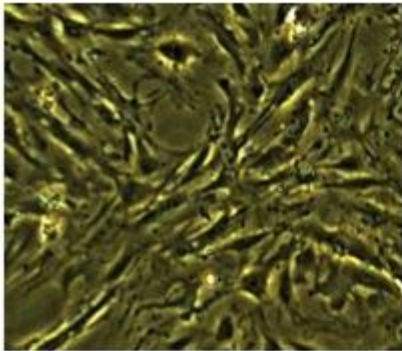
Impact

- Grow retina photoreceptor cells for artificial retina
- Grow brain cells on UNCD electrodes for bio-inspired electrodes for brain cell stimulation
- Grow generic nerve cells on UNCD for nerve stimulation (e.g., spinal cord cells)

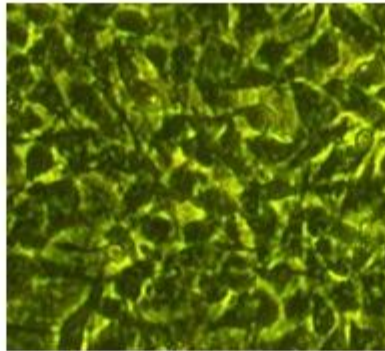


Use of UNCD Surfaces for Developmental Biology

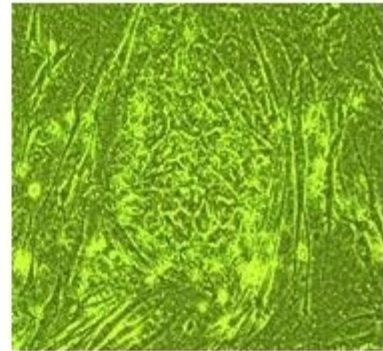
Optical pictures of different cell growth on UNCD



fibroblasts

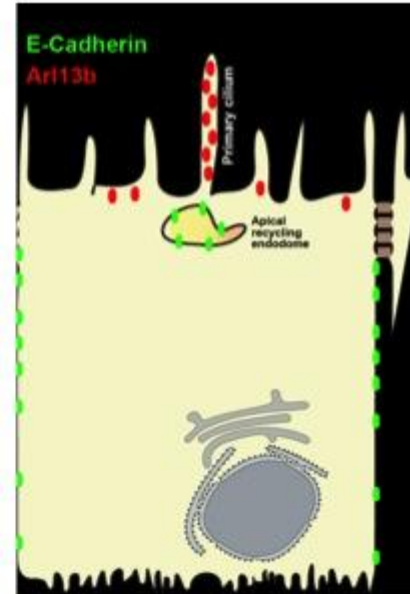
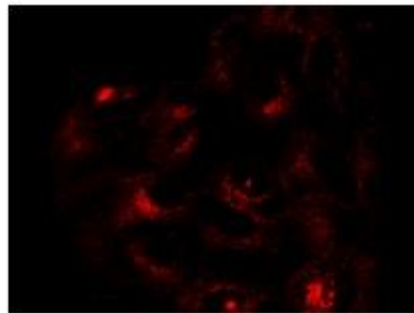
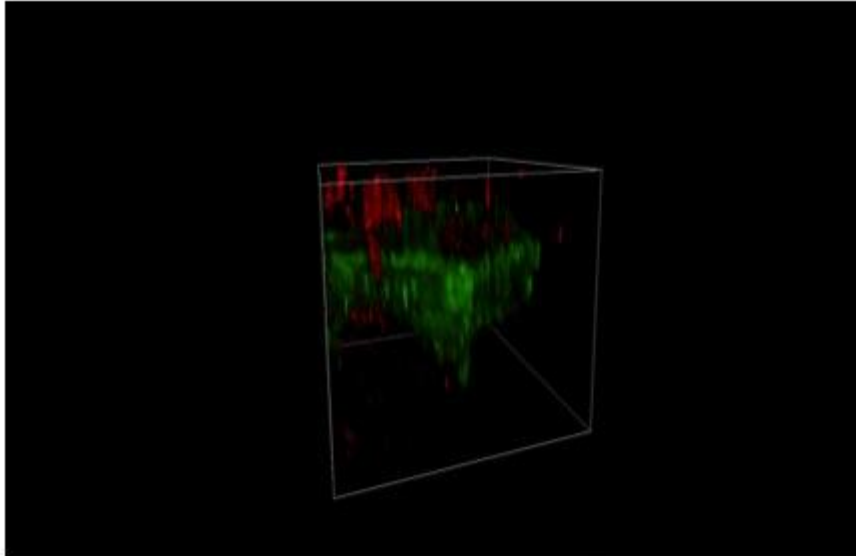


neurons



stem cells





Commercialization of UNCD Films



Founded (2003): Spun-off from ANL as 1st company from National Lab with founders / Lab holding equity
Founders: O. Auciello (currently: consultant), J.A. Carlisle (CTO)
J. Yerger (CEO)

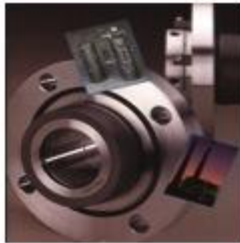
- Manufacturer of products with superior attributes due to the exceptional properties of UNCD
- **Exclusive licensee to portfolio of UNCD patents from Argonne National Laboratory-DOE**
- Platform technology with ability to create significant businesses across multiple industries and end-use applications
- Revenue generating with strong customer base (IBM, 3M, John Crane, Flowserve, NASA, Merck-Millipore)
- Privately held, investor-backed company located in Romeoville, Illinois
- 5,000 sq feet
- **16 employees (+5 TBH) as of 2011**
- **\$15 million+ in R&D funding, \$6 million private investment**
- **CLOSED INVESTMENT FOR \$5.2 MILLIONS WITH FOREIGN INVESTORS AND SERIES D (\$3 MILLIONS), JULY 8, 2011)**



U. S. Secretary of Energy Samuel Bodman and HR Judy Biggert at ADT ribbon cutting, April 2007



UNCD-Coated Mechanical Pump Seals as Energy Saving Components



PUMP SEALS

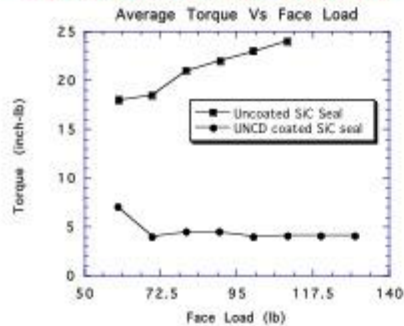
Uncoated SiC Seal



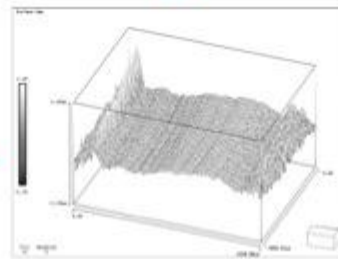
UNCD-coated SiC Seal



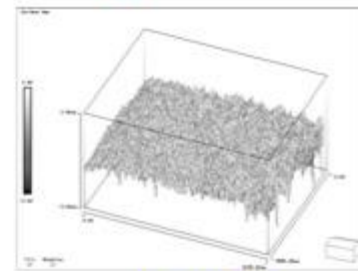
UNCD-Coated SiC Seals exhibit
~ 5-10 X lower COF than SiC



Test Conditions: Chamber Pressure: 100 psi Pump Speed: 3600 RPM



~0.8 um wear on SiC



No wear

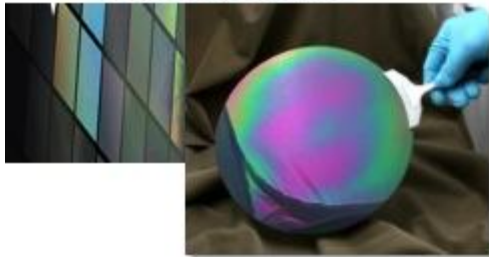
1st Product Launched by ADT
now in the market (2008)

Sumant/Auciello/Erdemir et al. Tribology Trans. 48 (2005) 24



Shipping Products Exploiting Superior Mechanical and Tribological Properties of UNCD

UNCD® Wafers
For Fab of MEMS,
Including Energy Harvesting
Market: \$1 billion



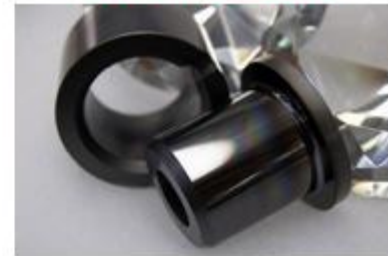
2010

UNCD®-coated Mech Pump Seals
For 20% Energy Savings in
Operation of Mechanical Pumps
Market: \$500 million



2009

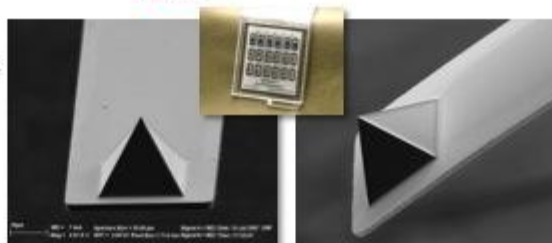
UNCD®-coated Gears
For Merck-Millipore Mixers
for Production of
Pharmaceutical Drugs
Market: \$1.5 billion



2011

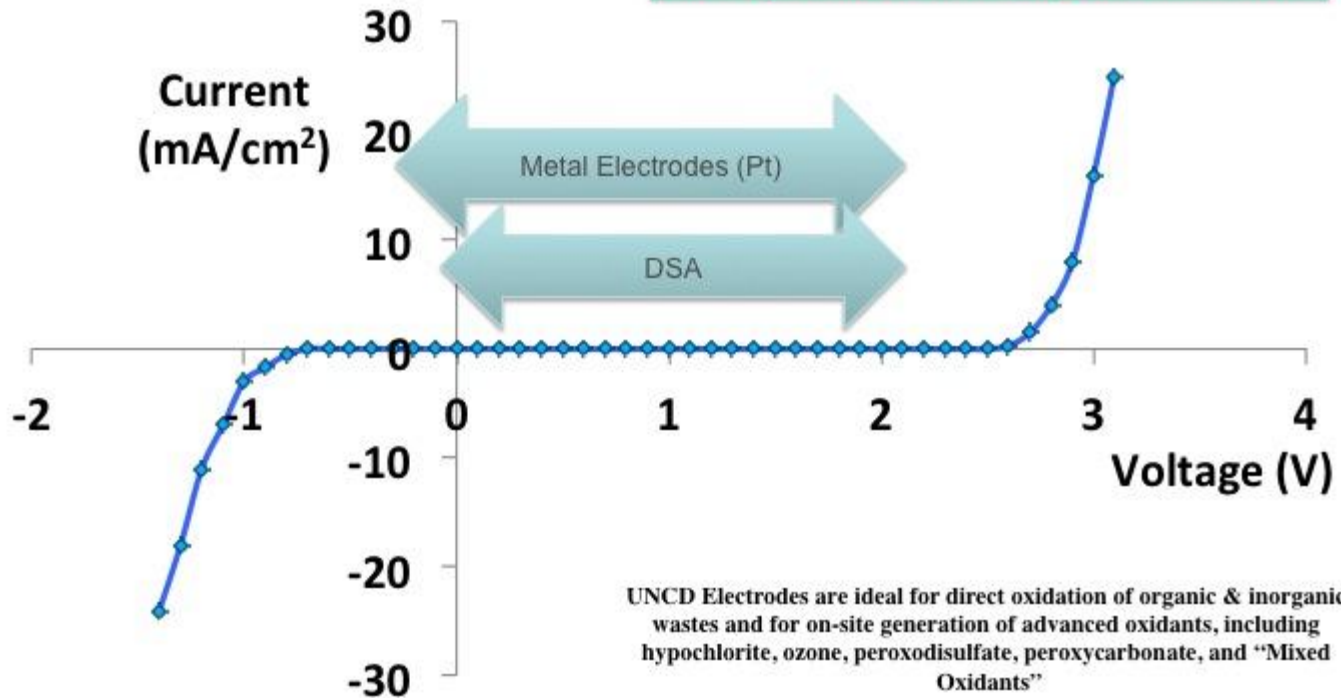
UNCD NaDia AFM Probes®
Market: \$150 million

2009



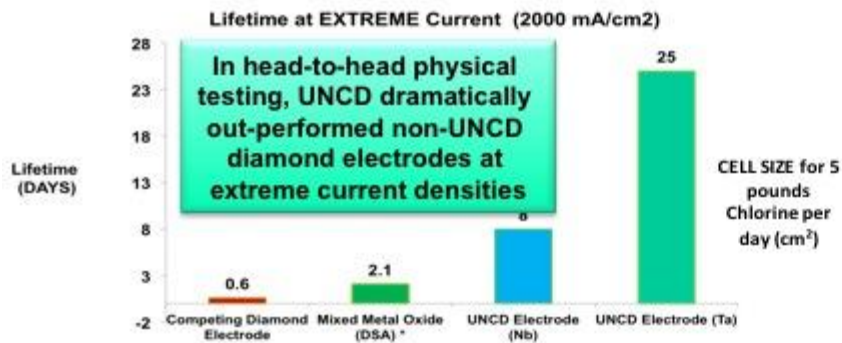
UNCD ELECTRODES FOR WATER PURIFICATION

Cyclic Voltammogram of UNCD
Electrode in 1M NaClO₄



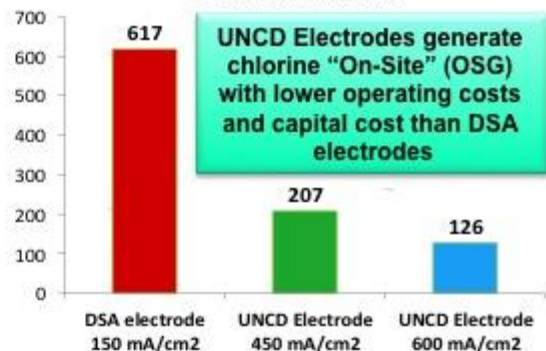
UNCD® Electrodes (Launched to Market, May 2011)

Bringing the Power of Diamond to Electrochemical Water Treatment Technologies



UNCD Electrodes are >10x most durable than **OTHER** diamond electrodes currently **on the market**

Electrochemical CELL SIZE in cm² to generate 5 Pounds of Chlorine PER DAY



**UNCD FILMS FOR NEXT GENERATION
ELECTRODES FOR FUEL CELL AND
LITHIUM-SULFUR BATTERIES CAPABLE OF
ENABLING A 500 MILES CAR**

TWO PATENTS PENDING



OBI

OBI

Original Biomedical Implants, Inc.



Founders **Technologist**

O. Auciello (UNCD and Oxide Film and Device Expert),
P. Gurman (MD, Bio-device manufacturing),
A. Berra (Biochemist and Animal Clinical Trials Expert)

Angel Investors

R. Geras (Owner/Director, La Salle Investments)
C. Davis (CIO, La Salle Investments)

OBI was Incorporated in Delaware on July 29, 2011



Product in Advanced State of Development: Eye Liquid Drain Valves for Treatment of Glaucoma (with U of Buenos Aires and Hospital Austral-Argentina)

(Pre-clinical Trials in Animals Close to Completion)

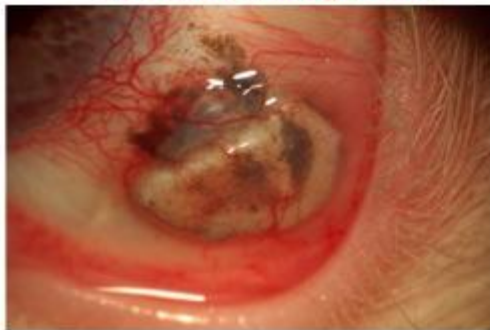


Dimensions:
~ 1.7 x 1 cm



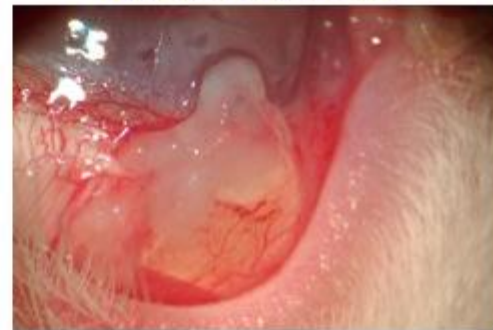
Baerveldt®
Pars Plana BG 102-350
Glaucoma Implant
(Abbott)

UNCD-Coated Commercial Ahmed Valve
Implanted in rabbit eye
Patent Pending (2012)



Ahmed valve
(coated with UNCD)
(NO Bio-fouling) (NO fibrosis)
in rabbit eye

Uncoated Commercial Ahmed Valve
Implanted in rabbit eye

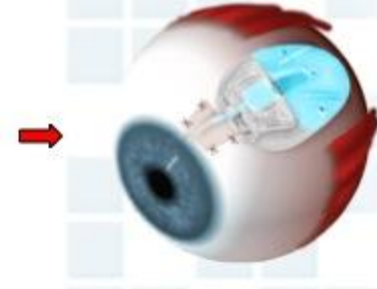


Ahmed valve
(silicone without coating)
(Bio-fouling (fibrosis) in rabbit eye)



Comparison of Ahmed Valve vs New UNCD-Coated Grid Draining Device for Treatment of Glaucoma (with U of Buenos Aires and Hospital Austral-Argentina)

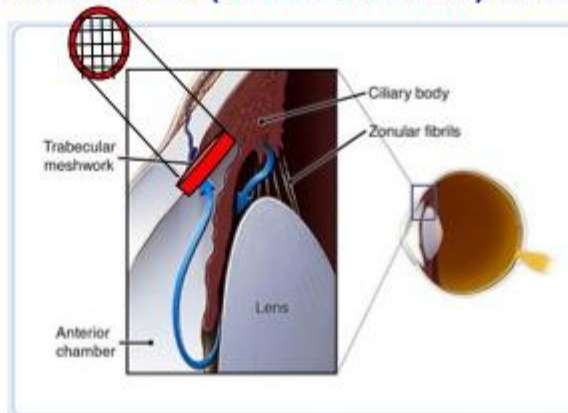
Current Glaucoma Treatment with Ahmed Valve



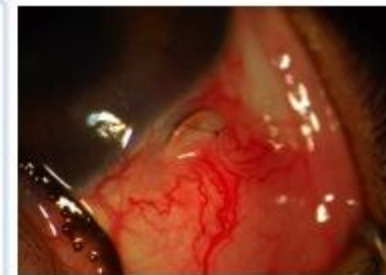
New UNCD-Coated Grid (3 mm diameter) Draining Concept



UNCD-Coated Cu Grid
implanted in rabbit eye
for ~ 12 months
(NO bio-rejection at all)



PATENT PENDING



Uncoated Cu Grid
implanted in rabbit eye
for ~ 24 hrs
(strong bio-rejection)

Product in Advanced State of Development for Treatment of Retina Detachment
(Pre-clinical Trials in Animals Close to Completion) (with UBA/Hospital Austral-Argentina)

Schematic Conventional Treatment for Retina Detachment



New Treatment for Retina Detachment

Patent Pending (2012)

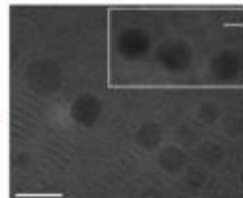
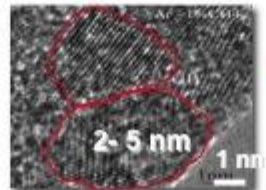


Imagen HRTEM
Nanopartículas
superparamagnéticas



Advanced Diamond Technologies Development of UNCD Coating for Jarvik 2000 Heart Pump



UNCD[®] as an anti-thrombotic coating
for ventricular assist devices

- Recent results show UNCD is highly effective at inhibiting adsorption of clot-forming proteins.
- UNCD can be further improved by adjusting its surface roughness and chemistry. Virtually zero adsorption observed in laboratory experiments.
- Current application of VADs is for temporary use (2 years) until patient can receive permanent heart replacement from donor.
- ADT is now working with Jarvik Heart to develop VADs that will last for ten years (chronic implants) based on combined wear resistance, anti-clot properties.
- **Started NIH SBIR I (2011) to finish development of UNCD-heart valve looking at FDA (1-2 years)**

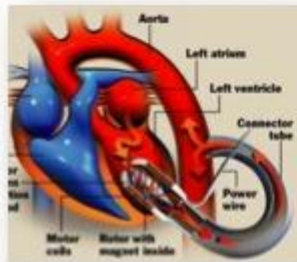


OBI (Original Biomedical Implants)

Founders: O. Auciello, B. Geras, C. Davis, P. Gurman, A. Berra

UNCD Bio-coatings for Near Future Biomedical Products

Stent



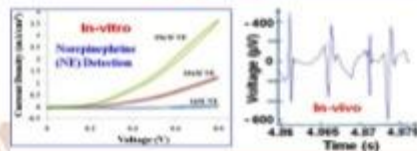
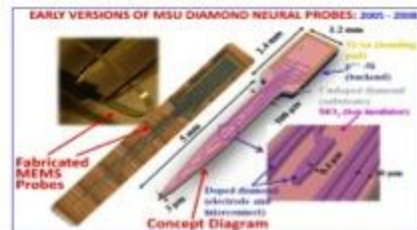
Artificial Hips



Artificial knees



New Polymer composite including diamond
(Patent Pending)



Neural Electrodes



£ 290

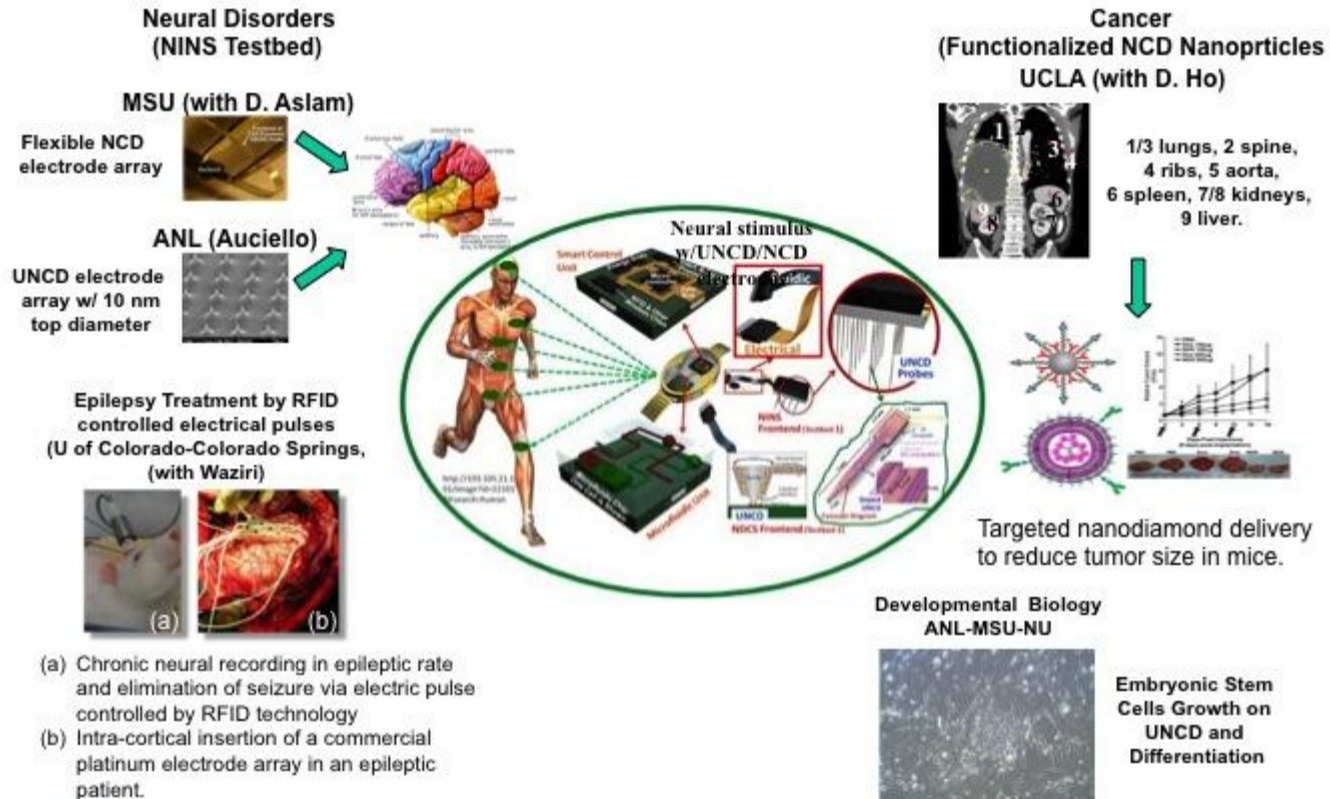
£ 300

£ 555

Dental Implant

The Future of Nanocarbon-Based Biotechnology

"Nanocarbon-Enabled Biomedical Implants"



Conclusions

- THE FUNDAMENTAL AND APPLIED SCIENCE ON MULTIFUNCTIONAL OXIDES ULTRA-NANOCRYSTALLINE DIAMOND (UNCD) FILMS PROVIDE MATERIALS WITH UNIQUE COMBINATION OF PROPERTIES, INCLUDING EXCELLENT BIOCOMPATIBILITY FOR A NEW GENERATION OF INDUSTRIAL, MICRO/ NANOELECTRONICS, AND IMPLANTABLE BIOMEDICAL DEVICES
- THE NEXT BIG STEP FORWARD, **UNDERWAY**, IS TRANSLATING THE SCIENCE AND TECHNOLOGY OF MULTIFUNCTIONAL UNCD INTO A NEW GENERATION OF MULTIFUNCTIONAL DEVICES AND SYSTEMS FOR INSERTION INTO THE MARKET
- THE MARKET IS RIPE FOR A NEW GENERATION OF BIOCOMPATIBLE UNCD AND OXIDE-BASED IMPLANTABLE BIOMEDICAL DEVICES AND INDUSTRIAL COMPONENTS AND MICRO/NANOELECTRONIC DEVICES

